EZ-USB™ FX2G3 SDK user guide

About this document

Scope and purpose

The EZ-USB™ FX2G3 SDK user guide provides comprehensive instructions and guidelines for effectively utilizing the EZ-USB™ FX2G3 family of USB device controllers.

Intended audience

This guide is intended for software developers, firmware engineers, and system integrators in the biometrics, scanner, camera, video, and imaging markets.

- **Software developers:** Professionals developing applications and firmware for the EZ-USB™ FX2G3 device controllers
- **Firmware engineers:** Engineers responsible for writing and maintaining firmware for EZ-USB™ FX2G3-based systems
- **System integrators:** Experts involved in integrating EZ-USB™ FX2G3 controllers into larger systems and ensuring compatibility
- **Technical project managers:** Managers overseeing projects that involve the development and integration of EZ-USB™ FX2G3 controllers

About this product group

Product family

Infineon's EZ-USB™ FX2G3 is a family of highly integrated USB 2.0 peripheral controllers with higher clock frequency and improved processing capabilities such as extended memory options and increased peripherals that support the demanding data processing tasks.

Target applications

- Industrial HMI monitors and panels
- Healthcare and lifestyle

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1 Introduction

The EZ-USB™ FX2G3 family of USB2 device controllers is designed to meet the demands of established USB2 applications in biometrics, scanners, cameras, video, and imaging markets. EZ-USB™ FX2G3 leverages Arm® Cortex®-M4 (CM4) and Cortex® M0+ (CM0) microcontrollers, complemented by 512 KB flash memory, KB SRAM, and 128 KB ROM.

The controllers also include Serial Communication Blocks (SCB), a crypto engine for enhanced security, and a high-bandwidth data subsystem that facilitates DMA data transfers from LVCMOS input to USB output at speeds up to 480 Mbps, suitable for USB Hi-Speed-based host systems. A 1024 KB SRAM is integrated within the high-bandwidth data subsystem to provide ample buffering for data.

1.1 EZ-USB™ FX2G3 SDK components

The SDK includes reference projects for target applications that help you jump-start the process of developing EZ-USB™ FX2G3 controller applications. A detailed overview of each code example is provided in the corresponding *README.md* file.

Subsequent sections of the user guide refer to the **CYUSB2318-BF104AXI** part of the EZ-USB™ FX2G3 controller. For information on using other products, refer to the Using the reference projects with other products section of this document.

- **mtb-example-fx2g3-hello-world:** Simple application that toggles GPIOs and outputs messages through a UART transmit pin periodically
- **mtb-example-fx2g3-usbhs-device:** Implements a vendor-specific USB echo device which allows USB data transfers to be tested using a device-based loopback function or data source sink function. The EZ-USB™ FX Control Center GUI application can be used to test out the loopback as well as data source sink functionality
- **mtb-example-fx2g3-slave-fifo-in:** Implements the Infineon standard Synchronous Slave FIFO IN protocol over an LVCMOS interface and allows data transfer from an FPGA connected to the LVCMOS port to the USB host
- **mtb-example-fx2g3-slave-fifo-out:** Implements the Infineon standard Synchronous Slave FIFO OUT protocol over an LVCMOS interface and allows data transfer from the USB host to an FPGA connected to the LVCMOS port
- **mtb-example-fx2g3-uvc-uac:** Implements USB Video Class (UVC) and integrated USB Audio Class (UAC) functions. The UVC function streams the video data received over the LVCMOS interface from an FPGA. The UAC function streams audio data received from PDM microphones
- **mtb-example-fx2g3-flash-loader:** Implements USB Vendor Class and is designed to program the FPGA bit file onto the external SPI flash of the KIT_FX2G3_104LGA DVK's FPGA add-on board using the EZ-USB™ FX Control Center GUI application
- **mtb-example-fx2g3-optiga-trust-m:** Demonstrates the utilization and capabilities of the OPTIGA™ Trust M module included on-board with the EZ-USB™ FX2G3 kit for implementing security features such as device authentication
- **mtb-example-fx2g3-canfd-interface:** Demonstrates the CAN FD nodes' configuration using the EZ-USB™ FX2G3 device. CAN FD Node-1 sends a CAN FD frame to CAN FD Node-2 every second and vice versa. Each time a CAN FD frame is received, the user LED toggles and the received data is logged
- **mtb-example-fx2g3-jtag:** Implements a USB-JTAG protocol using the EZ-USB™ FX2G3 device, functioning as a USB-JTAG adapter compatible with Infineon's USB Serial Library
- **mtb-example-fx2g3-hid-cfu:** This code example demonstrates the implementation of a HID-based component firmware update (CFU) using the Microsoft CFU model alongside a USB echo device application

- **mtb-example-fx2g3-protocol-analyzer:** This code example demonstrates an application designed to capture and forward USB packets to a host. It runs on custom hardware and can communicate with Wireshark
- **mtb-example-fx2g3-slave-fifo-in-out:** This code example explains the configuration and usage of Sensor Interface Port (SIP) on the EZ-USB™ FX2G3 device to implement the Bidirectional Synchronous Slave FIFO protocol

1.2 Middleware libraries

The SDK uses the following middleware libraries to implement key features supported by EZ-USB™ FX2G3 applications:

- USBFXStack middleware library

The USBFXStack middleware Library has the following sub-components:

  - **LVCMOS IP driver:** Driver for the Sensor Interface Port (SIP) on EZ-USB™ FX2G3, which can be configured to function using the LVCMOS interface
  - **USB Stack:** An integrated USB stack that supports the Hi-Speed USB functionality on the EZ-USB™ FX2G3 device
  - **DMA Manager:** Provides a generic DMA channel abstraction for the DMA resources that move data across the LVCMOS and USB interfaces on the EZ-USB™ FX2G3 device
  - **Utility functions:** A set of utility functions that provide various functionalities including logging support, abstraction for USB data transfers, and fault handlers
- mtb-pdl-cat1 Peripheral Driver Library

  The mtb-pdl-cat1 Peripheral Driver Library (PDL) simplifies the software development for EZ-USB™ FX devices. The PDL integrates device header files, startup code, and peripheral drivers into a single package

  It is the driver library for the clock, GPIO, serial peripherals, TCPWM, USB Full Speed, QSPI, PDM, and I2C interfaces on the EZ-USB™ FX2G3 device
- FreeRTOS for Infineon MCUs

  The FreeRTOS kernel (variant, targeted for Infineon MCUs), is fetched as a set of standard C source files. In conjunction with a configuration header file available in the code examples, FreeRTOS is compiled from source for use with the applications

The standard Infineon HAL will not be supported on the EZ-USB™ FX2G3 device.
It is possible to configure all IP blocks, except LVCMOS and USBHS, using the Device Configurator tool. The LVCMOS and USBHS blocks shall be configured and used with the support provided by the USBFXStack middleware.

1.3 SDK dependencies

1.3.1 ModusToolbox™

ModusToolbox™ software is a collection of easy-to-use libraries and tools enabling rapid development with Infineon MCUs for applications ranging from wireless and cloud-connected systems, edge AI/ML, embedded sense and control, to wired USB connectivity using PSOC™ Industrial/IoT MCUs, AIROC™ Wi-Fi and Bluetooth® connectivity devices, XMC™ Industrial MCUs, and EZ-USB™/EZ-PD™ wired connectivity controllers.

The Eclipse IDE that comes with the ModusToolbox™ Tools package can be used to configure EZ-USB™ FX2G3 devices to develop and compile the firmware applications. This SDK version requires ModusToolbox™ v3.5 or higher.

ModusToolbox™ includes configuration tools, low-level drivers, libraries, and operating system support, most of which are compatible with Linux, macOS, and Windows-hosted environments. ModusToolbox™ supports IDEs like Eclipse and Visual Studio Code. For more details, see Getting started with ModusToolbox™.

1.3.2 EZ-USB™ FX Control Center

The EZ-USB™ FX Control Center software helps to fetch the USB device information, perform data transfer, or data loopback over USB endpoints, and measure USB data transfer performance. It also supports programming internal flash and external SPI flash memories. The EZ-USB™ FX Control Center software is available for download from the Infineon Developer Center. For more details, see the EZ-USB™ FX Control Center user guide in the Help section of the application.

1.4 Hardware dependencies

The KIT_FX2G3_104LGA DVK board can be used to evaluate EZ-USB™ FX2G3 solutions. For more details on the kit, refer to the KIT_FX2G3_104LGA DVK user guide.

2 Getting started with EZ-USB™ FX2G3 SDK

2.1 Software prerequisites

Table 1 Prerequisites

#	Software	Version
1	ModusToolbox™	3.5 or later
2	EZ-USB™ FX Control Center	0.1 or later

2.2 Environment setup

Download and install the ModusToolbox™ software from Infineon Developer Center.

The ModusToolbox™ tools are located at *<install_path>/ModusToolbox/tools_MAJOR.MINOR*.

If multiple versions of ModusToolbox™ software are installed on the PC, multiple tools will be present in the *<install_path>/ModusToolbox/* location. Therefore, use the `CY_TOOLS_PATHS` system variable to have the required set of tools. On Windows, open the **Environment Variables** dialog, and create a new System/User Variable (see Figure 1).

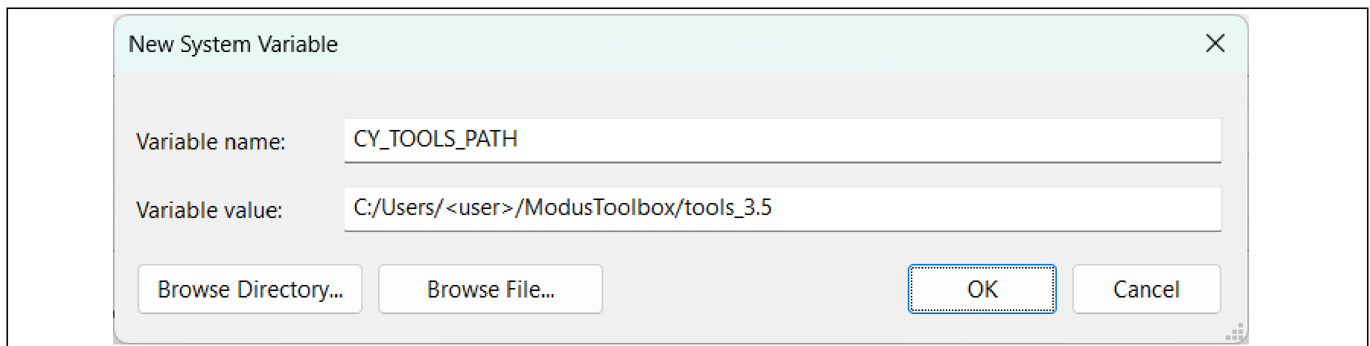

Figure 1 Environment variable updates

*Note: For **Variable value**, use a Windows style path with forward slashes.*
For example, `C:/Users/<user>/ModusToolbox/tools_3.5/`
Do not use alternative paths such as `/cygdrive/c/…`, `/gitbash/c/….`

Use the appropriate correct method for similarly setting environment variables in macOS and Linux for your system.

2.3 Using the reference projects

Each reference project provided with this SDK can be imported into Eclipse IDE for ModusToolbox™, and can be customized as per-user requirements and compiled. This section describes steps for project creation, compiling, programming, and debugging for EZ-USB™ FX2G3 solutions.

Note: These projects are designed to work specifically with the EZ-USB™ FX2G3 devices only. Changing the target device using the library manager can cause a firmware build failure. Create the project in Eclipse IDE for ModusToolbox™

1. Launch the Eclipse IDE for ModusToolbox™ software and select the workspace, as shown in Figure 2

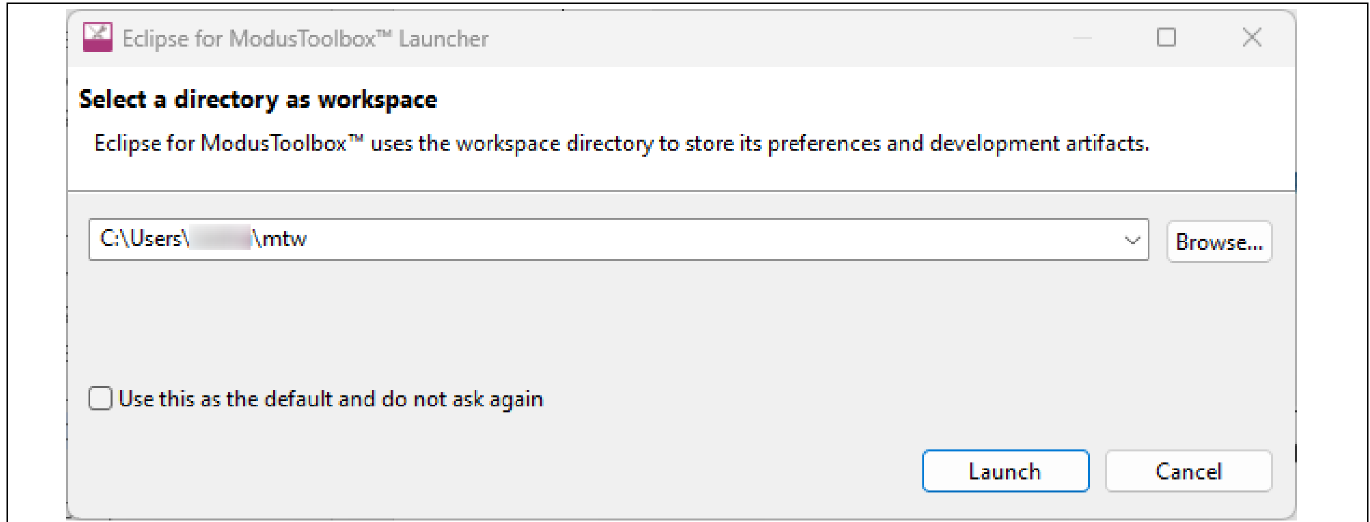

Figure 2 Launching Eclipse IDE for ModusToolbox™ software

2. Click **New Application** in the **Quick Panel** (or use **File** > **New** > **ModusToolbox™ Application**), as shown in Figure 3. This launches the Project Creator tool

Figure 3 Creating New Application

3. In **Choose Board Support Package (BSP) – Project Creator 2.X** window, do the following:
   a) Expand the **USB BSPs** dropdown
   b) Select **KIT_FX2G3_104LGA**
   c) Click **Next**

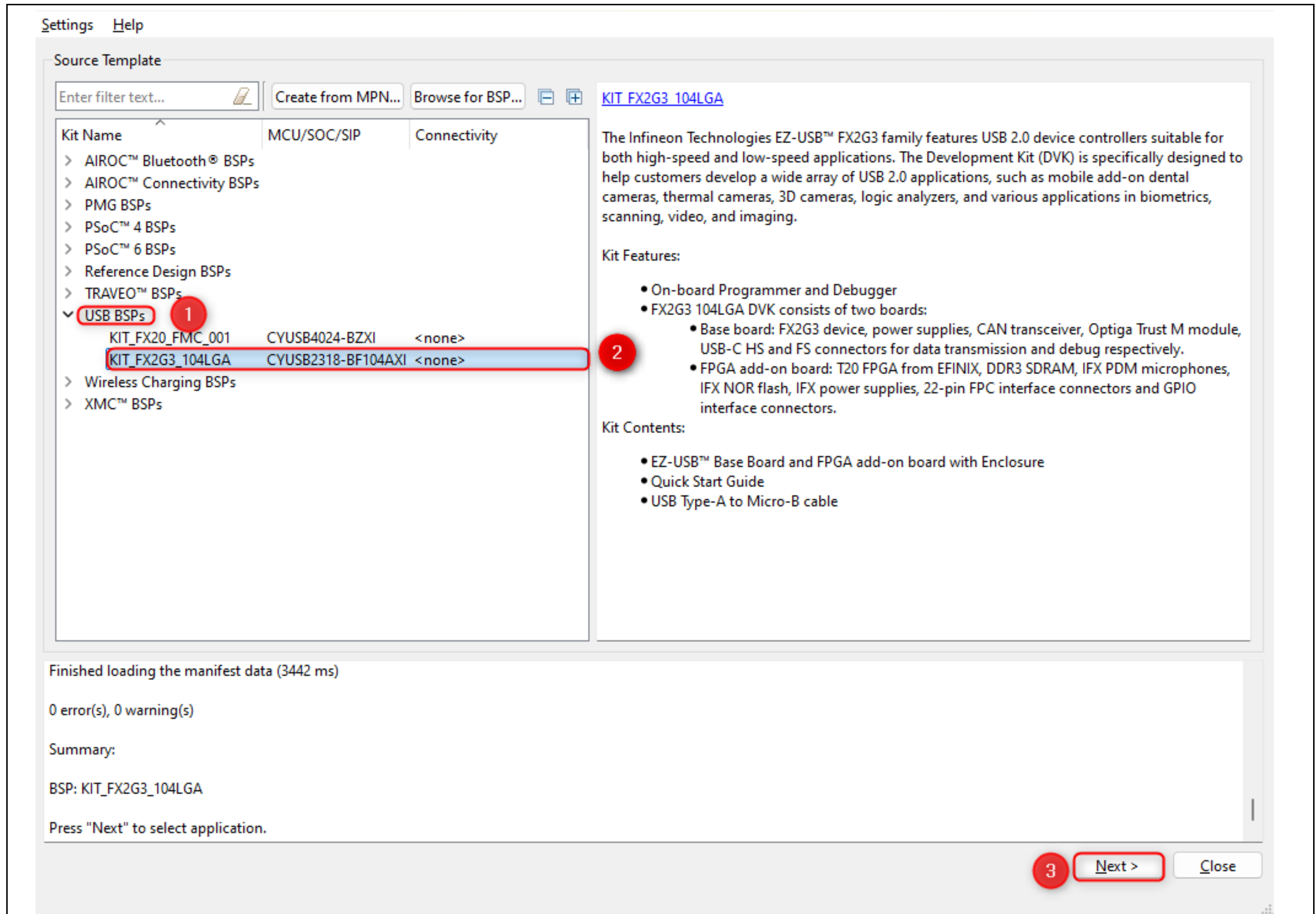

Figure 4 **Selection of BSP**

4. To create an application, choose the desired template from the list of available applications, as shown in Figure 5, and click on **Create**

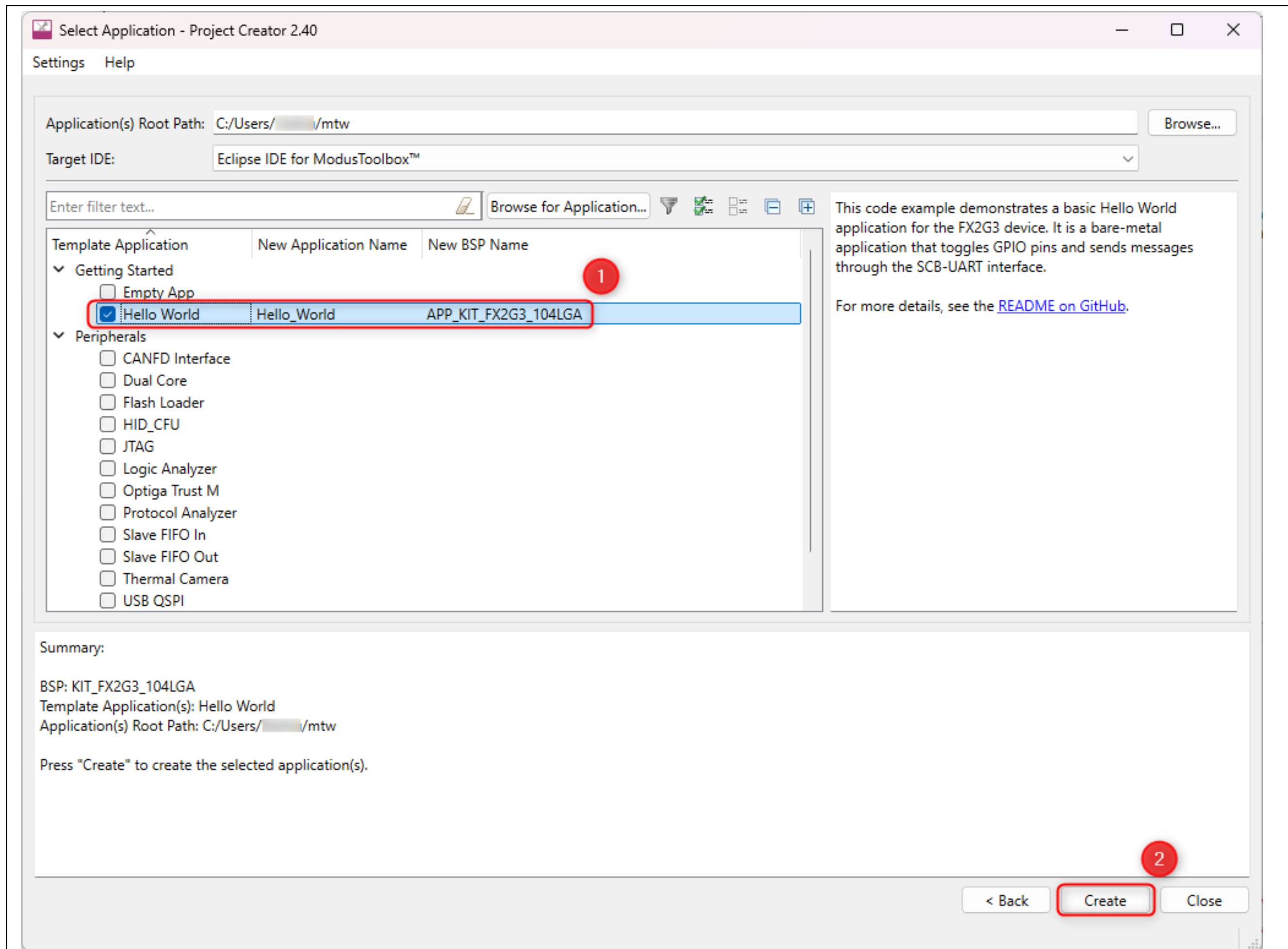

Figure 5 **Selection of an application**

The Project Creator GUI will close automatically if the creation of the project is successful or if it encounters an error in the creation of the project. If the project creation was successful, the project will be available in the Eclipse IDE for ModusToolbox™ to modify, compile, build, and debug. If project creation was unsuccessful, appropriate log messages are displayed in the Project Creator GUI log section or in the IDE's **Console** tab. For more information, refer to the ModusToolbox™ Project Creator user guide.

2.3.1 Using reference projects with other products

Each reference project is supported on one or more available EZ-USB™ FX2G3 products. To check a project's compatibility with a specific product, refer to Table or the project's *README.md* file. If a project is supported on the desired product, the project can be built for that product by following the steps detailed in the projects' respective *README.md* file under the **Using this code example with specific products** section.

Code example title	Product support			
	CYUSB2318-BF104AXI	**CYUSB2317-BF104AXI**	**CYUSB2316-BF104AXI**	**CYUSB2315-BF104AXI**
mtb-example-fx2g3-canfd-interface	✓	✓	✓	×
mtb-example-fx2g3-flash-loader	✓	✓	×	×
mtb-example-fx2g3-hello-world	✓	✓	✓	✓
mtb-example-fx2g3-hid-cfu	✓	✓	×	×
mtb-example-fx2g3-jtag	✓	✓	×	×
mtb-example-fx2g3-optiga-trust-m	✓	✓	✓	✓
mtb-example-fx2g3-protocol-analyzer	✓	×	×	×
mtb-example-fx2g3-slave-fifo-in	✓	✓	×	×
mtb-example-fx2g3-slave-fifo-in-out	✓	✓	×	×
mtb-example-fx2g3-slave-fifo-out	✓	✓	×	×
mtb-example-fx2g3-usbhs-device	✓	✓	✓	✓
mtb-example-fx2g3-uvc-uac	✓	✓	×	×

Each of the products supports different SCBs as specified below:

- **CYUSB2318-BF104AXI:** SCB0, SCB1, SCB2, SCB4, SCB5, SCB6
- **CYUSB2317-BF104AXI:** SCB0, SCB1, SCB2, SCB4, SCB5, SCB6
- **CYUSB2316-BF104AXI:** SCB0, SCB4, SCB5
- **CYUSB2315-BF104AXI:** SCB0

To enable UART logging through SCB for the CYUSB2315-BF104AXI product, refer to the **Note** in the Debugging the code examples section of this document.

2.4 Compile the reference project

EZ-USB™ FX2G3 solutions are designed to work with a flash-based USB bootloader. For the flash memory map and for more information on firmware operation, see Figure 13.

The Makefile located in the application is designed to disable or enable certain application features during the build process.

To start the build operation, follow the steps described in either the Using Eclipse IDE for ModusToolbox™ software, or Using CLI sections.

2.4.1 Using Eclipse IDE for ModusToolbox™ software

1. In **Project Explorer**, select the application ("Hello World" in this demonstration)
2. In **Quick Panel**, select **Build Application,** as shown in Figure 6

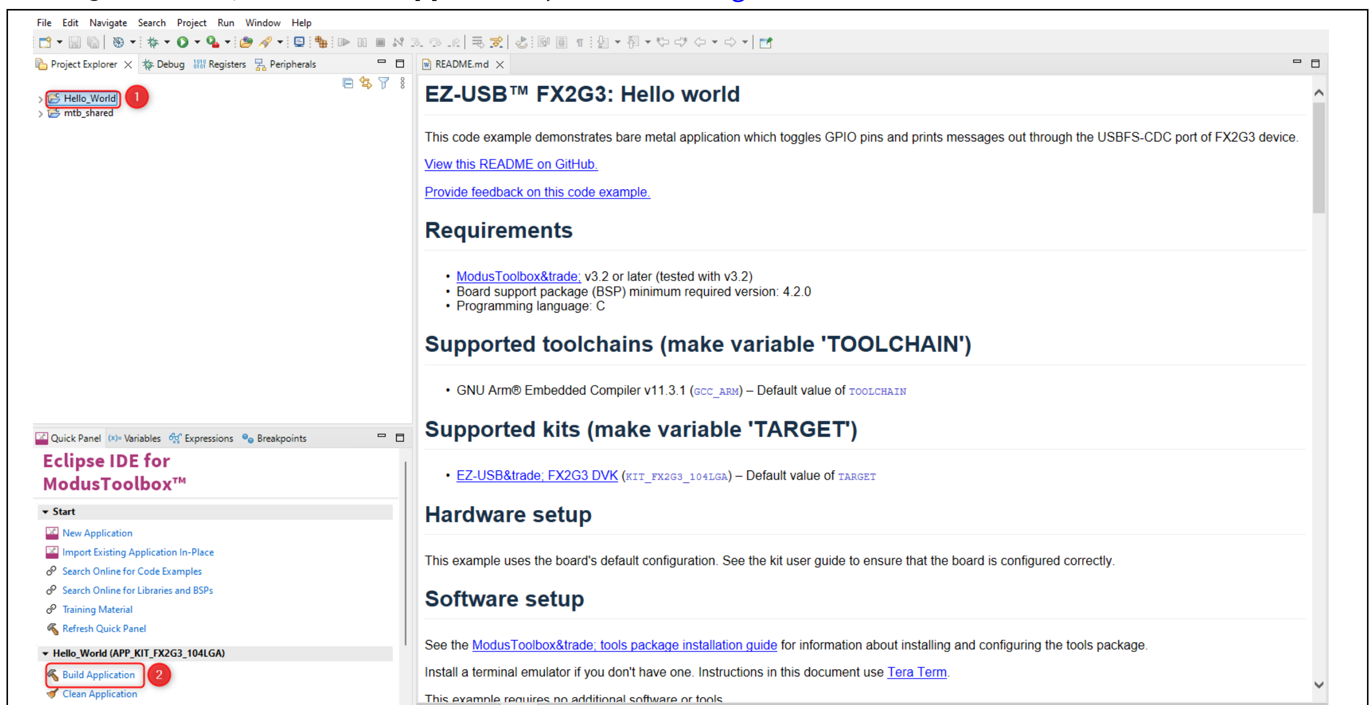

Figure 6 Building an application using Eclipse IDE for ModusToolbox™ software

2.4.2 Using CLI

1. Open terminal and navigate to the application directory
2. Run the following command:

```
make build -j8
```

2.5 Programming the EZ-USB™ FX2G3 device

This section describes programming the HEX file generated by building the project for the target, using the EZ-USB™ FX Control Center application. The HEX file generated will be at the *build/APP_KIT_FX2G3_104LGA/<CONFIG>/<APPNAME>*.hex* location within the application directory, where:

- Based on the `CONFIG` Makefile variable setting, "<CONFIG>" can be "DEBUG" or "RELEASE"
- "<APPNAME>" is the title of the application that was built
  For this example, "<APPNAME>" is "mtb-example-fx2g3-hello-world", and "<CONFIG>" is "RELEASE"

2.5.1 Programming using EZ-USB™ FX Control Center (Recommended)

The EZ-USB™ FX2G3 device comes with a pre-programmed USB bootloader.

1. Connect the *KIT_FX2G3_104LGA DVK* to the USB Host or PC. The device enumerates as a WinUSB device
2. EZ-USB™ FX2G3 device comes up as **EZ-USB FX bootloader**
3. Select the device and click **Program** > **Internal Flash**

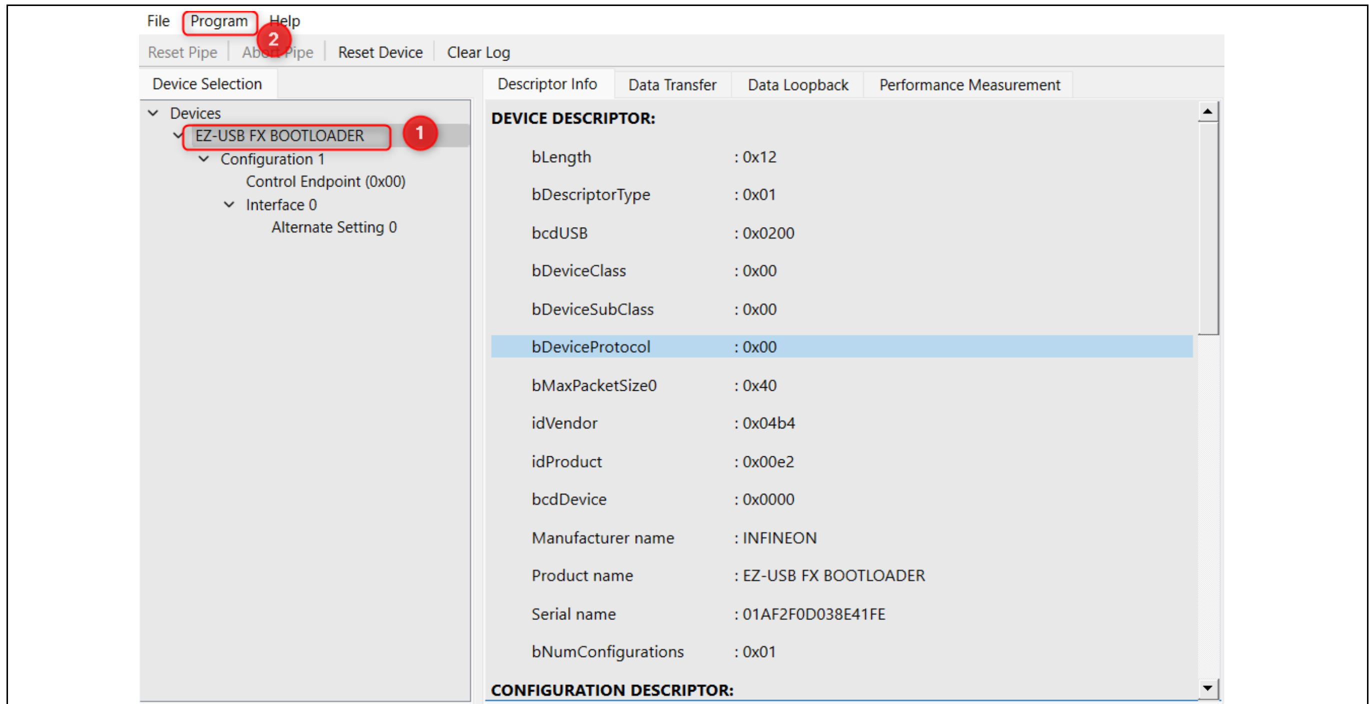

Figure 7 Programming EZ-USB™ FX2G3 using EZ-USB™ FX Control Center

4. Navigate to the generated hex file output folder and choose the application hex file
5. Confirm if the programming was successful in the log window

After the binary is programmed, the device performs a reset, and the new application starts execution.

Figure 8 Programming successful

2.5.2 Program application from ModusToolbox™

Click on the **Hello-World Program** link in the **Quick Panel** to program the code example to the kit directly from ModusToolbox™ using OpenOCD.

Note: KitProg3 or MiniProg4 should be connected to the kit's SWD pins for directly programming the kit from ModusToolbox™.

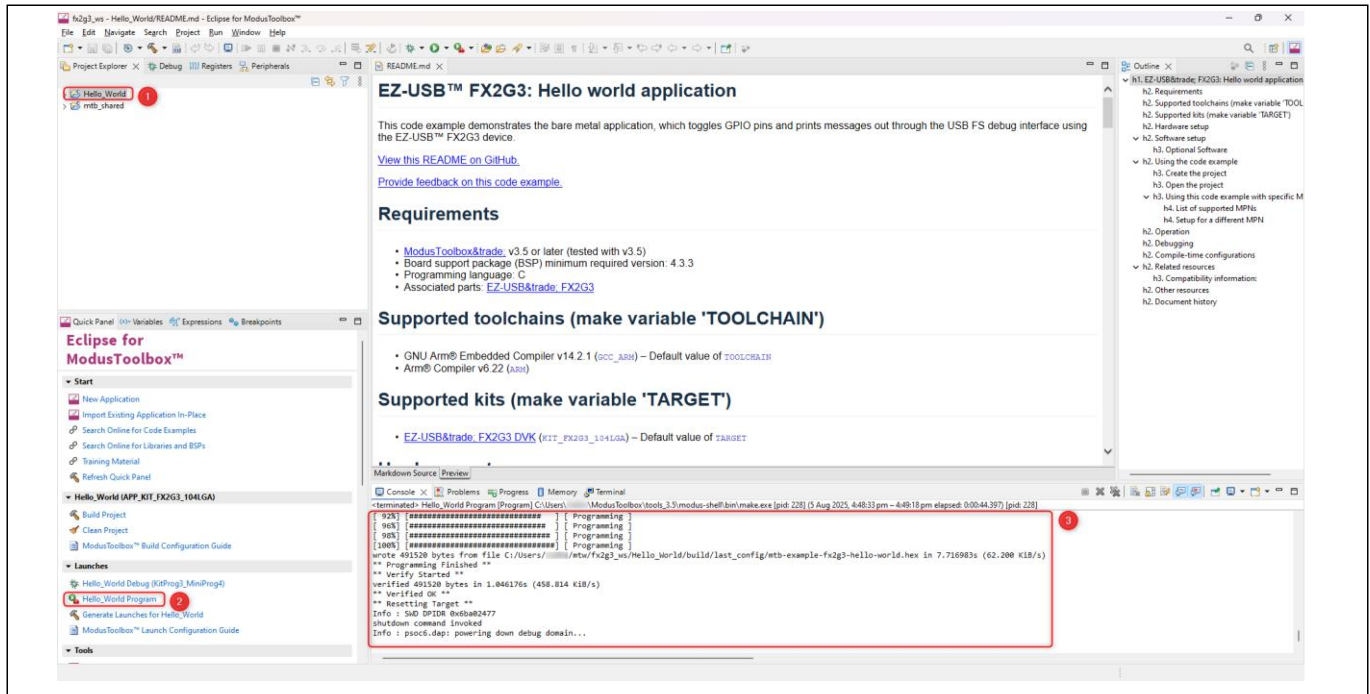

Figure 9 **Program directly from ModusToolbox™ using KitProg3 or MiniProg4**

2.5.3 Debugging EZ-USB™ FX code examples

Code examples can be debugged directly from ModusToolbox™ with a KitProg3 or MiniProg4 using OpenOCD.

- Click on the **Hello_World Debug** link in the **Quick Panel** to start a debug session for the Hello_World code example

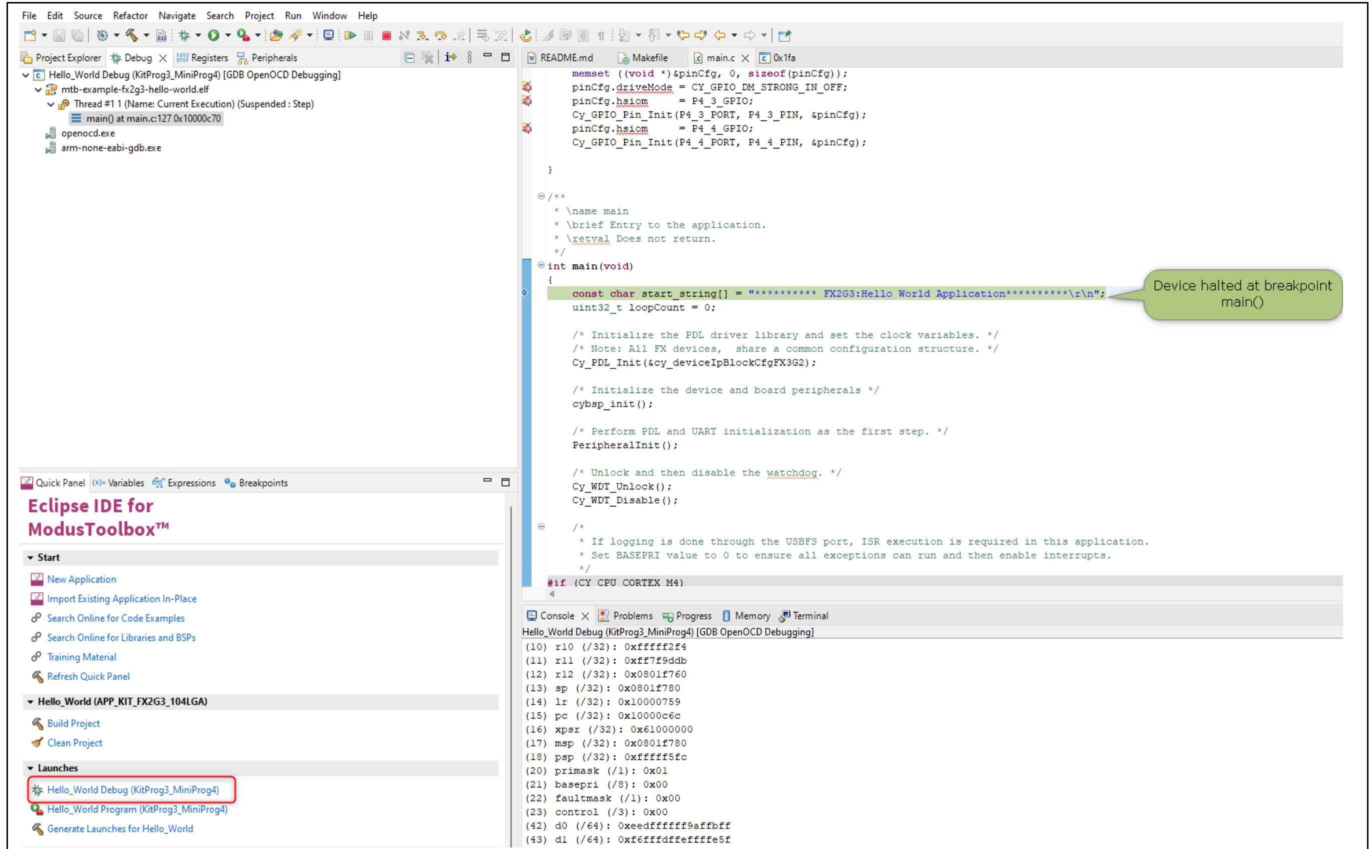

Figure 11 Debug session in progress for Hello World code example

3 EZ-USB™ FX2G3 firmware applications

A detailed overview of each code example is available in the corresponding *README.md* file.

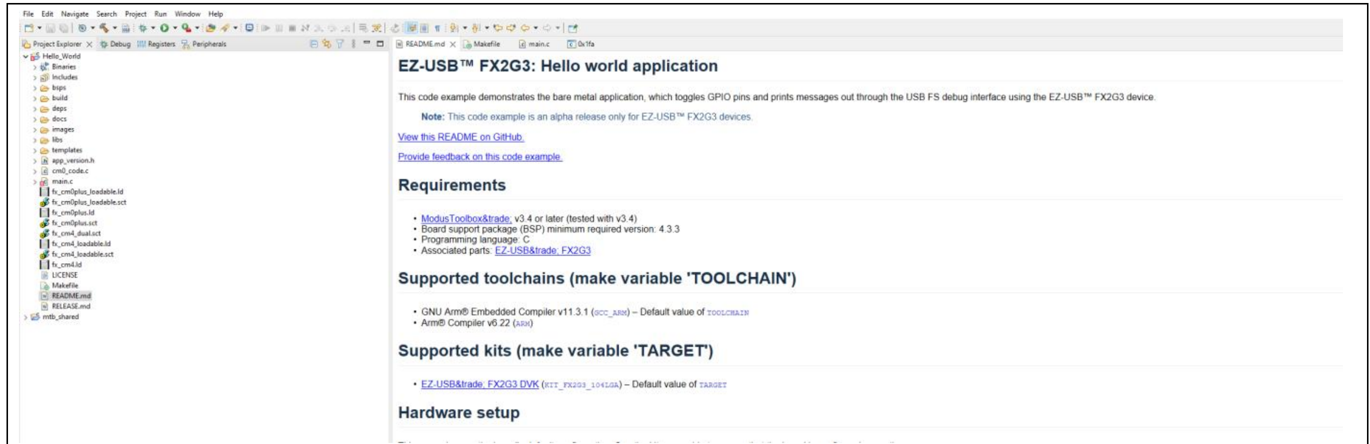

Figure 12 ***README* file for Hello World code example**

4 USB bootloader

A USB-based bootloader is preprogrammed onto the EZ-USB™ FX2G3 device to allow programming of custom firmware applications without having to make use of a dedicated SWD programmer.

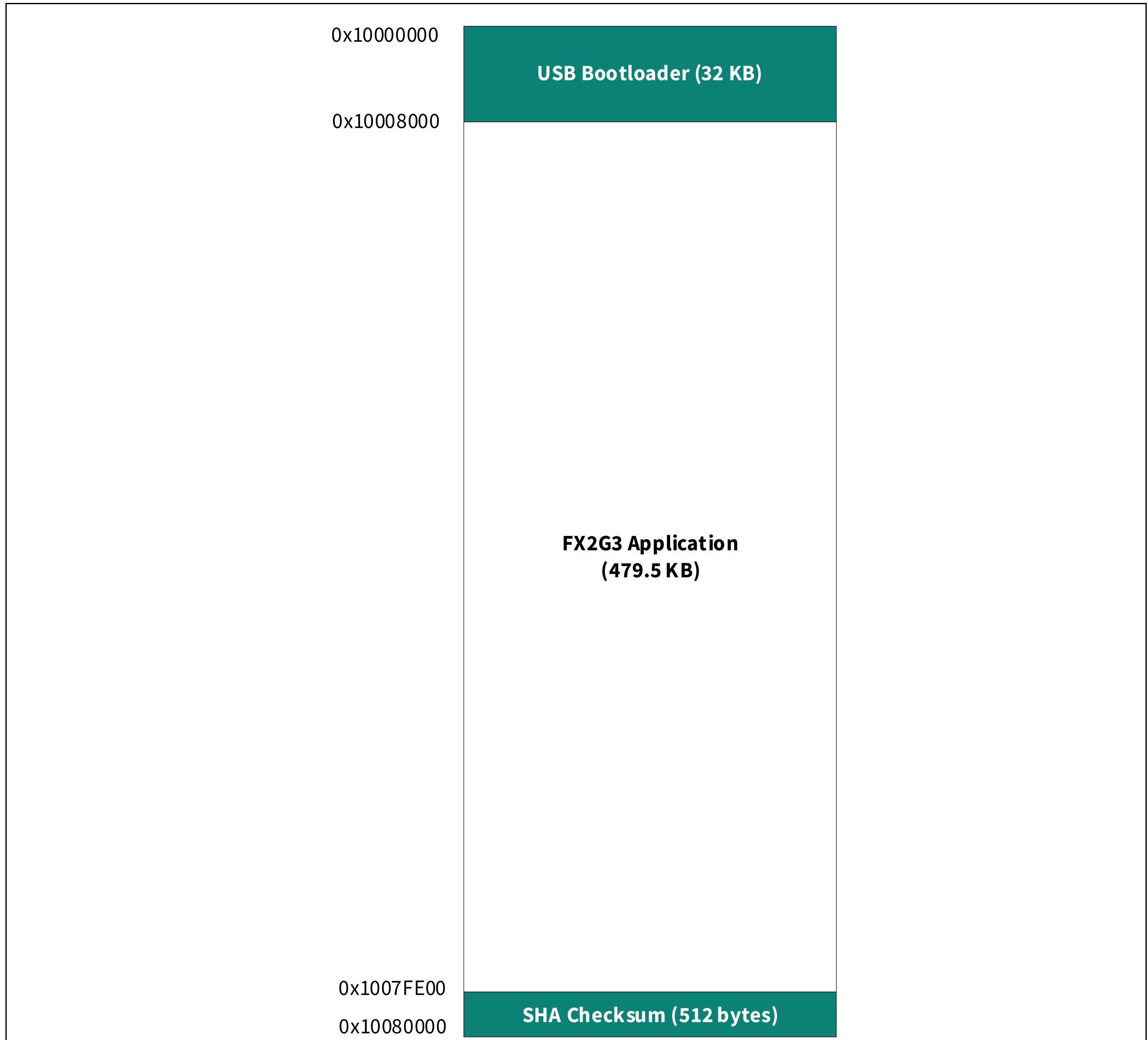

Figure 13 Flash memory layout of the EZ-USB™ FX2G3 device

Figure 13 shows the flash memory layout on the EZ-USB™ FX2G3 device with the CYUSB2318-BF104AXI or CYUSB2317-BF104AXI products. The USB bootloader occupies the first 32 KB of the on-chip flash memory and leaves the remaining 480 KB for application-specific usage. The location of the SHA-256 checksum is at address `0x1007FE00`.

For the CYUSB2316-BF104AXI and CYUSB2315-BF104AXI products, the bootloader occupies the first 32 KB of the on-chip flash memory and leaves the remaining 224 KB for application-specific use. The location of the SHA-256 checksum is at address `0x1003FE00`.

The last 512 bytes of the on-chip flash is expected to store a SHA-256 checksum calculated over the rest of the application-specific flash contents. The bootloader makes use of this checksum to verify the integrity of the application before transferring control to it.

If a valid application is not found in the flash, the bootloader proceeds to enumerate as a Hi-Speed USB device and allows for the programming of an application binary onto the flash.

4.1 Firmware build for bootloader compatibility on different products

As specified in the previous section, the bootloader looks for the SHA-256 checksum at different addresses, based on the product used. Therefore, the firmware build must place the SHA-256 checksum at the correct address for the desired product. This is achieved at build time, where the appropriate linker script is automatically selected by the application Makefile based on the target product being used. Instructions on building the applications with bootloader compatibility for other products is documented in the Using the reference projects with other products section of this document.

4.2 Returning control to the USB bootloader

Once the firmware binary has been programmed onto the EZ-USB™ FX2G3 device flash, the bootloader will keep transferring control to the application on every subsequent reset.

To stay in Boot mode without transferring control to the application, perform the following steps:

1. Press and hold the **PMODE** (**SW1**) switch
2. Press and release the **RESET** switch or power cycle the device
3. Release the **PMODE** switch

This is achieved by sensing the P13.0 pin on the device and staying in Bootloader mode after a device reset if the pin is HIGH.

If such GPIO control is not possible, the application can be used to instruct the bootloader to stay in Boot mode and not transfer control on the next reset.

This is achieved by storing an 8-byte signature into a specific RAM region and initiating a soft (not power-on) reset. As the RAM content is retained across the soft reset, the bootloader will detect this signature in the RAM location and stay in Boot mode, thereby allowing a firmware update.

The Boot mode signature to be stored is shown in Table 2.

Table 2 Boot mode request passed through SRAM

SRAM location	Expected value	String
0x0800 03C0	0x544F 4F42	“BOOT”
0x0800 03C4	0x4544 4F4D	“MODE”

4.3 EZ-USB™ FX2G3 dual-core boot flow

Note: This section is only applicable to the CYUSB2318-BF104AXI product. Other EZ-USB™ FX2G3 products contain a single Cortex®-M0+ (CM0+) core.

The EZ-USB™ FX2G3 controller incorporates a Cortex®-M0+ (CM0+) core as well as a Cortex®-M4 (CM4) core. All the applications in the SDK are designed to run on either core, based on the value of the *CORE* Makefile variable.

When the EZ-USB™ FX2G3 device powers up (or comes out of reset), only the CM0+ core will be running and the Cortex®-M4 is held in reset. The CM0+ core executes the ROM-based boot code before transferring control to the user application at the beginning of the on-chip flash memory (address 0x1000 0000). This can be the starting of the EZ-USB™ FX2G3 USB bootloader, or of the EZ-USB™ FX2G3 application if the USB bootloader is not being used.

This location is expected to hold a CM0+ vector table including the reset vector. The ROM-based boot code will identify the reset vector address and branch to that address to start running the bootloader (or the application).

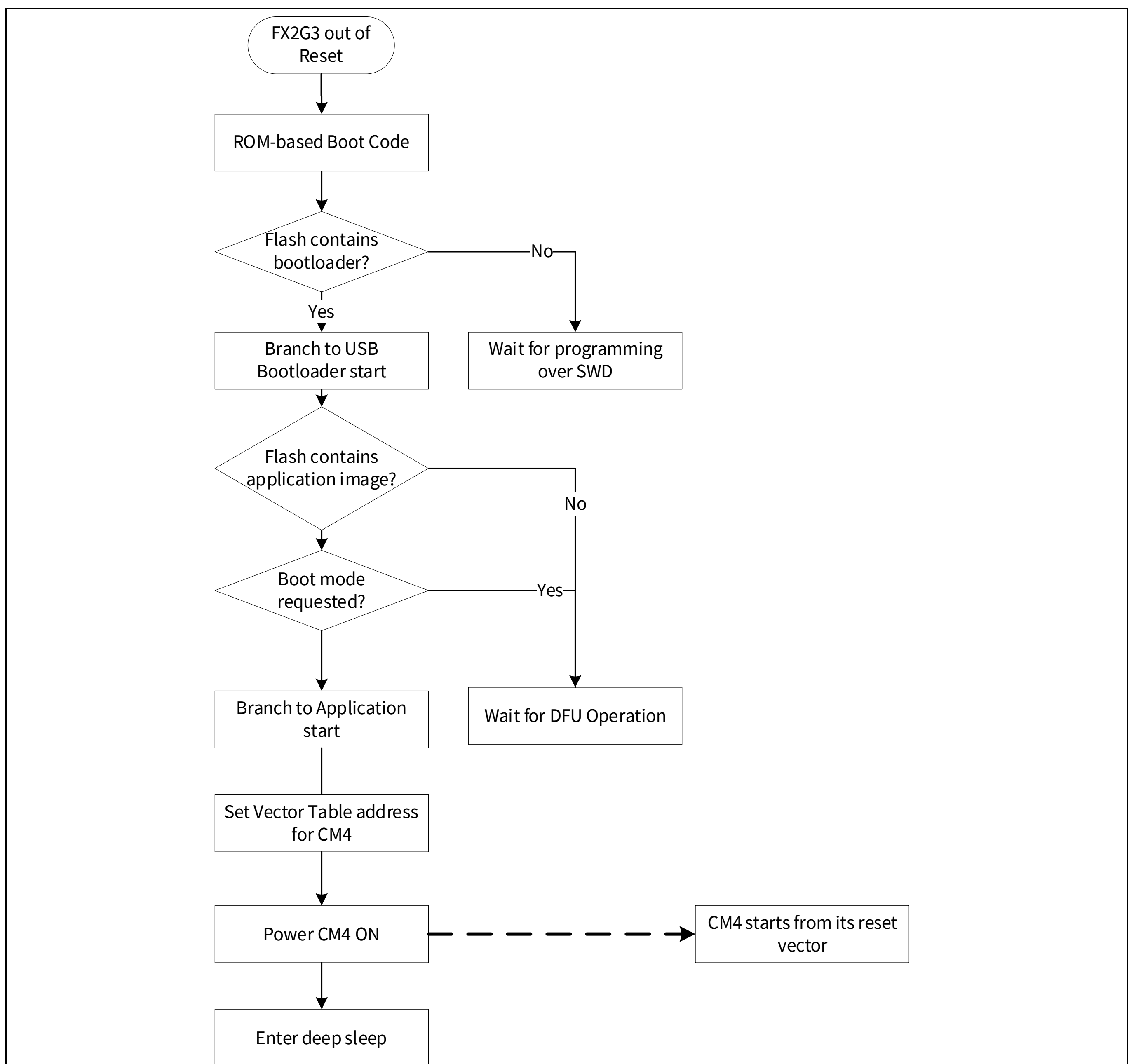

Figure 14 EZ-USB™ FX2G3 CM4 boot flowchart

The USB bootloader checks the flash region from address 0x1000 8000 onwards for the presence of a valid application image. If it is found and a Bootloader mode request is not detected, the bootloader transfers control to the application image by setting the stack pointer and branching to the reset vector found in the vector table at address 0x1000 8000.

The CM0+ core launches execution of the firmware application. If the application is built to run on the CM4 processor, as the first step, the CM0+ core sets the vector table location for the CM4 processor. This is typically set to the flash location 0x1000 8400 (1 KB offset from the start of the application). The bootloader then powers the CM4 core on, at which point the core starts running from its reset vector location. Once the Cortex®-M4 core has been powered on, the CM0+ has no more work to do and enters Deep Sleep state. The code to be executed on the CM0+ core is pre-compiled into a binary blob and embedded into the firmware applications as part of the `Cm0Code` array which is allocated at the start of the flash region using linker directives.

5 Firmware architecture

The following sections summarize the firmware design flow using the SDK components like middleware, board support packages (BSP), and the Peripheral Driver Library (PDL).

A detailed overview of application architecture is provided in the corresponding *README.md* file.

5.1 RTOS usage in firmware libraries

When the EZ-USB™ FX2G3 SDK components are built with the default options, they make use of the FreeRTOS middleware, as summarized in the following sections.

5.1.1 Memory configuration

The FreeRTOS configuration used enables dynamic memory allocation and makes use of the heap_4 allocation strategy. A memory block of 32 KB in the system SRAM region is reserved for the heap usage by default. This value can be changed (if required) by modifying the `configTOTAL_HEAP_SIZE` value in the *FreeRTOS/FreeRTOSConfig.h* file and rebuilding the project.

5.1.2 RTOS tasks

FreeRTOS is configured to use task priorities in the range of 0 (lowest) to 15 (highest).

- **Idle task created by FreeRTOS Kernel:** Created with a priority level of 0 and stack allocation of 400 bytes
- **Timer task created by FreeRTOS Kernel:** Created with a priority level of 14 and stack allocation of 2 KB
- **High-BandWidth DMA manager task:** Created with a priority level of 10 and with a stack allocation of 2 KB
- **USB device stack task:** Created with a priority level of 10 and stack allocation of 2 KB

5.1.3 Message queues

The High BandWidth DMA manager and USB device components of USBFXStack make use of message queues to pass information about events of interest to the respective tasks for processing. Only minimal handling of interrupts is done in the ISR and the bulk of the work is expected to be done in the task.

- **High BandWidth DMA message queue:** Interrupts received from all High BandWidth DMA sockets are passed to the HBDma manager task through this message queue after the interrupt has been masked out in the ISR
- **USB device stack message queue:** Interrupts received from the USBHS IP blocks are passed to the USB stack task through this message queue

5.1.4 RTOS timers

The USB stack makes use of an RTOS timer instance to schedule the re-enablement of USB low-power mode (LPM) transitions after the link has returned to an active state. This delay is used to ensure that any pending transactions on the link can be completed before the link enters a low-power state again.

On a USB 2.x connection, the transition to L1 state is disabled as soon as the link enters L1 and re-enabled 10 ms after the link returns to the L0 state.

5.2 EZ-USB™ FX2G3 device initialization

See Section 4.3 for details of how the EZ-USB™ FX2G3 device powers up and how the CM0+ core may enable the CM4 core which can implement all of the remaining functionality.

Note: The code examples can be built for Cortex® M0+ core based on Makefile options. In that case, the CM0+ core launches and continues execution of the firmware application.

5.2.1 Clock initialization

Once the selected core starts running, the first task to be performed is to enable the various on-chip clocks required for operation.

A simplified view of EZ-USB™ FX2G3 internal clock tree is shown in Figure 15. The primary clock sources available on the EZ-USB™ FX2G3 device are:

- **Internal main oscillator (IMO):** This generates a clock with a frequency of 8 MHz ± 2% and is automatically enabled when the device powers up. The relevant clock buffers are enabled such that the Cortex®-M0+ core can function based on this clock when the device is out of reset
- **Integrated low-speed oscillator (ILO):** This generates a clock with a frequency of 32 kHz ± 10% and is used to clock the watchdog as well as other low-power circuits. This is the only clock source which will be active when the EZ-USB™ FX2G3 device is in Deep Sleep state
- **External crystal oscillator (ECO):** Any high-speed clock derived from the IMO will have the same 2% error range of the IMO which is too high for use as a USB Hi-Speed clock reference. A more accurate (< 0.5%) clock reference is required for USB operation on the EZ-USB™ FX2G3 device. This is generally provided by a crystal oscillator circuit which uses a 24 MHz crystal connected between the XTALIN and XTALOUT pins. There is an option for this circuit to use a 24 MHz clock input connected on the XTALOUT pin instead of the crystal oscillator

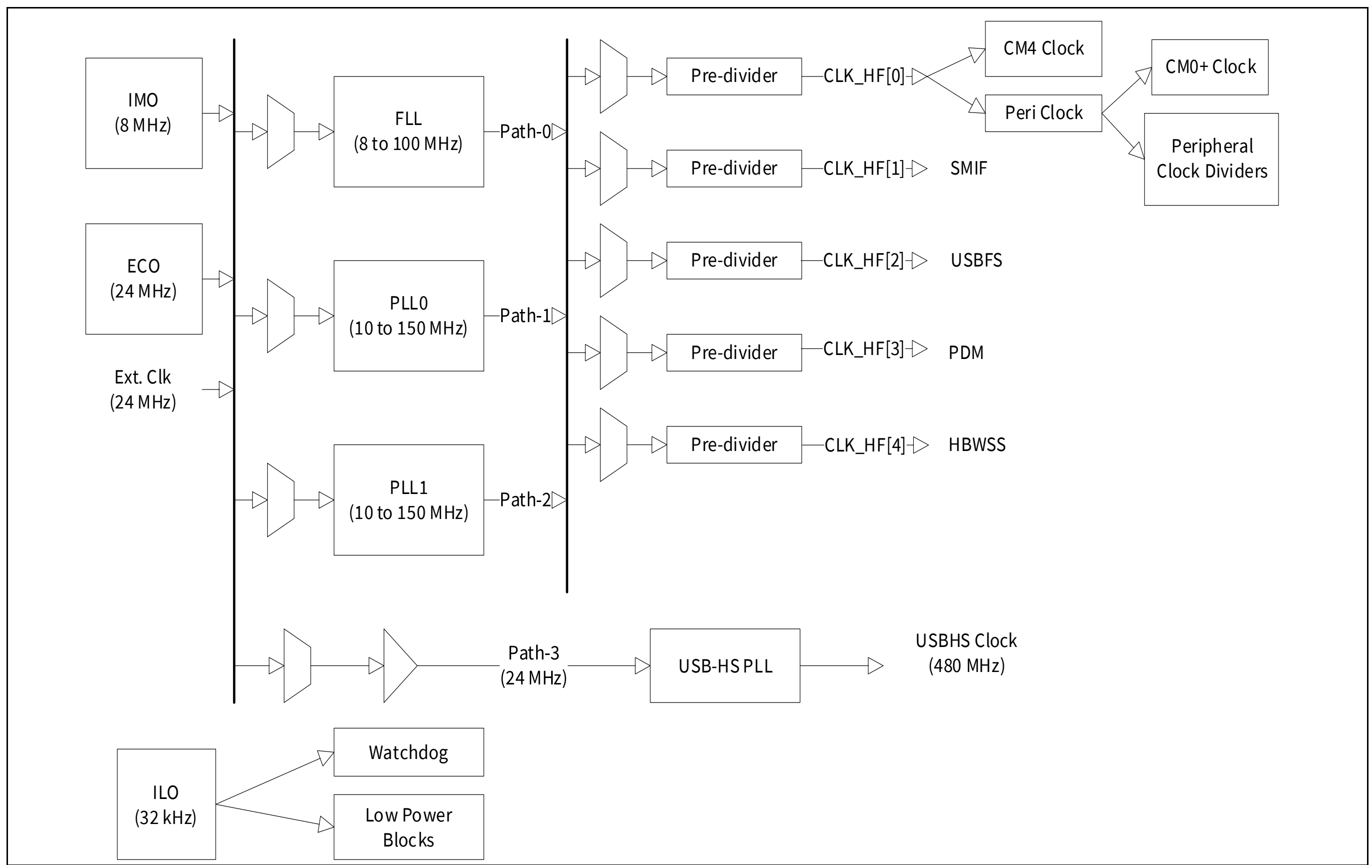

Figure 15 **Internal clock tree of EZ-USB™ FX2G3**

The high-speed clocks required for EZ-USB™ FX2G3 operation are provided by:

- **Frequency-locked loop (FLL):** FLL can generate frequencies up to 100 MHz
- **Phase-locked loop (PLL0 and PLL1):** EZ-USB™ FX2G3 has two internal general-purpose PLLs, each of which can be independently configured to generate clocks up to 150 MHz

The outputs from the FLL, PLLs, and ECO are then used to generate all other internal clocks required for EZ-USB™ FX2G3 operation through a set of clock buffers and dividers. EZ-USB™ FX2G3 has five root clocks which need to be connected to one of these high-speed clock sources.

1. clk_hf[0] clock tree provides the clock input to the Cortex®-M4 and Cortex®-M0+ cores, the AHB-based DMA engines, and the programmable peripherals such as SCB, PWM, and CAN FD
   a) clk_hf[0] is divided by an integer factor between 1 and 256 to derive the clk_fast clock which is used as the clock for the Cortex®-M4 core. The maximum clk_fast frequency supported is 150 MHz which is the same as the maximum clk_hf[0] frequency supported
   b) clk_hf[0] is divided by an integer factor between 1 and 256 to derive the clk_peri clock. As the maximum clk_peri frequency supported is 100 MHz, use a divider of 2 and reduce clk_peri to 75 MHz when clk_hf[0] frequency is set to 150 MHz. If clk_hf[0] frequency is restricted to 100 MHz, It is possible to configure both clk_fast and clk_peri to operate at 100 MHz
   c) clk_peri is divided by an integer factor between 1 and 256 to derive the clk_slow clock which is used by the Cortex®-M0+ core as well as the AHB-based DMA engines. The maximum clk_slow frequency supported is 100 MHz

d) clk_peri is divided by a set of programmable dividers to provide clocks to other on-chip peripheral blocks such as SCB, PWM, and CAN FD. The USB, SMIF, and PDM blocks have their own dedicated clock paths, which need to be configured separately

2. clk_hf[1] is used as the clock for the Serial Memory Interface (SMIF) block which connects EZ-USB™ FX2G3 device to external serial memory devices. The maximum clk_hf[1] frequency supported is 75 MHz
3. clk_hf[2] is used as the clock for the USB Full-Speed block and set to a frequency of 48 MHz whenever this needs to be used
4. clk_hf[3] is used as the root clock for the PDM and I2S-based audio interfaces. The maximum frequency supported is 75 MHz; the frequency can be set based on the audio interface requirements
5. clk_hf[4] is used as the clock for the High BandWidth subsystem including the DMA buffer RAM. The MCU cores on the EZ-USB™ FX2G3 device can only access the DMA buffer RAM when the clk_hf[4] clock is enabled. The maximum frequency supported is 150 MHz

The programmable dividers and other device settings can be reconfigured using the **Device Configurator** tool available from Eclipse IDE for ModusToolbox™. To launch the tool for a project, refer to the figure below Figure 16.

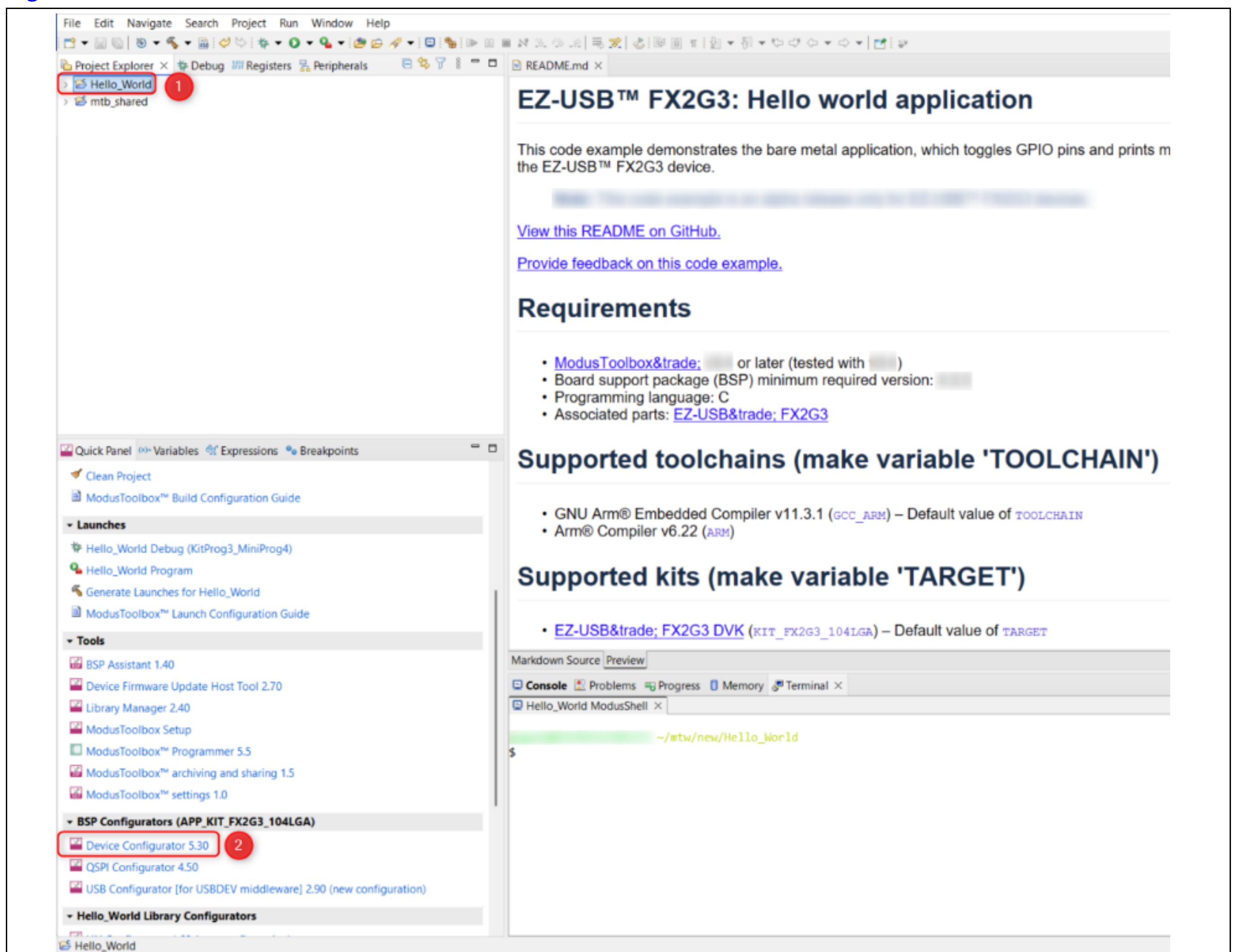

Figure 16 **Launch the Device Configurator tool**

The `cybsp_init()` function provided in the kit's BSP configures all the clocks for a typical use case:

- PLL0 is used to generate a clock of 150 MHz which will drive clk_hf[0], clk_hf[1], and clk_hf[4]
- PLL1 is used to generate a clock of 48 MHz which will drive clk_hf[2]
- FLL is used to generate a frequency of 24.576 MHz which will drive clk_hf[3]
- clk_fast is set to 150 MHz, allowing the Cortex®-M4 CPU to run at its maximum supported rate
- clk_peri and clk_slow are set to 75 MHz, which is the maximum possible frequency when clk_hf[0] is set to 150 MHz
- clk_hf[1] for the SMIF interface is set to a frequency of 75 MHz
- clk_hf[4] for the High BandWidth subsystem is set to a frequency of 150 MHz

5.2.2 On-reset initialization

Most of the sample EZ-USB™ FX2G3 applications make use of a part of the DMA buffer RAM for storing data structures like the USB descriptors to be used during device enumeration. When linker directives have been used to place read/write data sections in the DMA buffer RAM, the CPU should access the buffer RAM before the application initialization is complete and the `main()` function is executed.

The clk_hf[4] root, which provides the clock input to the High BandWidth subsystem is disabled during device power-up and is enabled explicitly before this memory region can be accessed by either of the Cortex®-M4 or M0+ cores.

The `Cy_Fx2g3_OnResetInit()` function is used to enable the clk_hf[4] clock (and connect it to the IMO output at 8 MHz) and to enable the High BandWidth subsystem completely. It is mandatory for this function to be called from the `Cy_OnResetUser()` function if the application intends to place any read/write data directly in the DMA buffer RAM region.

5.2.3 I/O configuration

Most of the digital I/Os on the EZ-USB™ FX2G3 device support multiple functions and are configured to select the desired function.

The common I/Os and functions used in the EZ-USB™ FX2G3 sample applications are summarized as follows:

Table 3 Common EZ-USB™ FX2G3 I/O usage

EZ-USB™ FX2G3 pin	GPIO ID	Function
B16	P11.1	**SCB4 UART receive pin:** Input buffer enabled, output drivers disabled for High-Z state
B15	P11.0	**SCB4 UART transmit pin:** Configured as strong drive output
H12	P10.0	**SCB0 I2C data pin:** Configured as open-drain output
G12	P10.1	**SCB0 I2C clock pin:** Configured as open-drain output
G5	P4.0	**Vbus detect pin:** When LOW, it indicates that the Vbus supply is present on the USB port
K9	P11.2	**SWD data pin for CPU debug:** Configured with internal resistive pull-up enabled
K10	P11.3	**SWD clock pin for CPU debug:** Configured with internal resistive pull-down enabled

5.2.4 Peripheral initialization

EZ-USB™ FX2G3's peripherals are initialized using the APIs from the mtb-pdl-cat1 Peripheral Driver Library (PDL).

5.2.4.1 Watchdog reset disable

The watchdog reset module on the EZ-USB™ FX2G3 device is enabled by default and will result in resetting the device after about 4.3 seconds of operation. The watchdog either needs to be cleared periodically or the reset function is disabled during start-up. All the code examples provided in the EZ-USB™ FX2G3 SDK disable the watchdog reset by calling the `Cy_WDT_Unlock()` and `Cy_WDT_Disable()` functions during start-up.

5.2.4.2 Debug logging enable

The EZ-USB™ FX2G3 firmware library and applications make use of a configurable logging infrastructure which is capable of routing messages to either a UART console or to a virtual COM port implemented using the USBFS port of the EZ-USB™ FX2G3 device (USB debug or J3 port on the KIT_FX2G3_104LGA DVK).

UART initialization for logging

If the debug logs are to be output through a UART interface, enable the corresponding SCB block and configure for this purpose. This is done by calling the `InitUart()` function with the SCB index (4 by default) as a parameter. As the SCB is only used for logging (output) purposes, the application does not prepare to receive any data on the corresponding UART_RX pin.

The UART used for logging is configured for operation at 921,600 baud with one stop bit and no parity bits.

USBFS (debug) initialization for logging

If the debug logs are to be output through the USBFS debug port, enable the USBFS block from the "utilities" component of the USBFXStack middleware and configure for enumeration as a Communications Device Class – Abstract Control Model device which provides a virtual COM port functionality.

The USBFS block initialization is performed implicitly when the debug logger module is enabled with the output interface selected as `CY_DEBUG_INTFCE_USBFS_CDC`. It is expected that a physical USB cable connection from the USB debug port to the host controller is present when this interface is being used for logging.

Logging configuration

The debug logging is implemented using a RAM-based buffer. The data to be logged is formatted and stored into this buffer and then output through the selected interface. Select the following configuration parameters before enabling the debug logging module. By default, the reference projects are configured for debug logging.

Table 4 Logging configuration parameters

Configuration parameter	Function
pBuffer	Pointer to a RAM buffer where the log messages are stored temporarily
bufSize	Size of the RAM buffer in bytes. Recommended to be 1 KB or more
dbfIntfce	Selects the interface through which logs are output from EZ-USB™ FX2G3. Currently supported values are all SCB UART modules and the USBFS debug port
traceLvl	Selects the verbosity of output messages. Log messages with lower priority will be filtered out by the debug module. The levels are: • **Level 1:** Error messages • **Level 2:** Warning messages • **Level 3:** Info messages • **Level 4:** Trace messages. It is not recommended to enable the output of trace messages
printNow	Boolean flag indicating whether debug logs should be output as soon as possible. Recommend setting this value to true

The logger module is enabled by calling the `Cy_Debug_LogInit()` function. If the USBFS debug port is used for logging output, it is recommended that a delay be provided after calling this function to allow the CDC device enumeration and driver binding to be completed before any other operations are performed.

5.3 USB block operation

The USB HS block is initialized and configured using the USB "device" (common) component of the USBFXStack middleware library.

5.3.1 USB initialization

Steps for enabling and operating the EZ-USB™ FX2G3 USB interface:

1. Register ISRs for USBHS interrupts so that the respective driver functions are called to handle the interrupts
   a) The `usbhsdev_interrupt_u2d_active_o_IRQn` and `usbhsdev_interrupt_u2d_dpslp_o_IRQn` interrupts are associated with the USBHS block. Call the `Cy_USBHS_Cal_IntrHandler()` function provided in the firmware library when either of these interrupts is asserted. In an RTOS-enabled configuration, this function will return 'true' if a context switch is to be triggered before the ISR exits
2. To power on and configure the USB blocks for operation, the internal power supplies in the USBHS block are enabled and the PLL is configured to generate the 480 MHz clock. As this clock is used by multiple other blocks on the EZ-USB™ FX2G3 device, this needs to be enabled independent of the type of USB connection to be established. The `Cy_USB_USBD_Init()` function performs this initialization and also creates the USB stack task and associated message queues
3. Register the descriptors (device descriptor, configuration descriptor, string descriptors, device qualifier descriptor, binary object store descriptor, etc.), which are to be returned by the device during device enumeration. These descriptors are expected to be stored in dedicated memory buffers and the corresponding pointers are registered with the USB device stack using the `Cy_USBD_SetDscr()` function. It is recommended (though it is not mandatory) that each of the descriptors be placed at 16-byte aligned addresses in the DMA buffer RAM
4. Register callback functions to handle important USB connection-related events using the `Cy_USBD_RegisterCallback()` API. At a minimum, callbacks for the `CY_USB_USBD_CB_RESET`, `CY_USB_USBD_CB_SETUP`, and `CY_USB_USBD_CB_SET_CONFIG` events need to be registered

5. If the system that uses the EZ-USB™ FX2G3 device is self-powered (not powered through the USB port), firmware needs to wait until the Vbus supply is present on the USB port before attempting to enable the connection. The mechanism used to do this is system/circuit specific. On the KIT_FX2G3_104LGA DVK, this is done using the VBUSDETECTN (P4.0) GPIO. This signal will be HIGH (pulled up to V3P3_1P8) when Vbus supply is not present and LOW (connected to GND) when Vbus supply is present
6. Enable the USB connection by calling the `Cy_USBD_ConnectDevice()` API. The desired USB speed of operation can be passed as a parameter. The USB stack will automatically initialize the link to the best possible speed less than or equal to the requested value based on the upstream port's capabilities

5.3.2 USB enumeration

5.3.2.1 USB link initialization

When `Cy_USBD_ConnectDevice()` is called to enable the USB connection, the USB stack attempts to initialize the USB link as defined in the USB specification.

5.3.2.2 USB control request handling

The initial part of USB device enumeration involves the host querying the device capabilities through the set of USB descriptors. The USB stack automatically handles most of these requests by returning the pre-registered set of descriptors.

When the stack receives any control request which it is unable to handle, the request is passed to the application through the callback function registered for the `CY_USB_USBD_CB_SETUP` event. The 8-byte data associated with the control request can be retrieved from the `setupReq` field in the USBD stack context structure.

Note that the callback for the control requests is issued from the USB driver task context and it is recommended not to block this function for an extended period of time. Where a delay is required as part of the control request handling, the application can defer the handling to its own task using inter-process communication methods such as shared variables, message queues, or event groups.

The application has four options for handling a control request:

1. **Acknowledge the request and complete the status handshake:** This option is applicable only if there is no data phase associated with the request (`wLength` = 0). The `Cy_USBD_SendAckSetupDataStatusStage()` function can be called to acknowledge the control transfer with no errors
2. **Send data to the host and then complete the status handshake:** This option is applicable when there is an IN data transfer associated with the request (`wLength` ≠ 0 and MSB of `bmRequestType` is set to '1'). The `Cy_USB_USBD_SendEndp0Data()` function can be called to initiate the data transfer. It is recommended that the data to be sent be placed in a 16-byte aligned buffer located in the DMA buffer RAM. If the data is not placed in the DMA buffer RAM, the API makes a copy of the data in the buffer RAM and then initiates the data transfer from there. Note that all the data to be sent in response for the control request is expected to be sent through a single call of the `Cy_USB_USBD_SendEndp0Data()` API. The API waits until the DMA transfer to the host has been completed or a timeout period of 2.5 seconds has elapsed. If the user wants to respond with a Zero Length Packet (ZLP) to an IN data transfer, `Cy_USBD_SendEgressZLP()` API should be used, followed by `Cy_USBD_SendAckSetupDataStatusStage()` to complete the status handshake
3. **Receive data from the host and then complete the status handshake:** This option is applicable when there is an OUT data transfer associated with the request (`wLength` ≠ 0 and MSB of `bmRequestType` is '0'). The transfer can be initiated using the `Cy_USB_USBD_RecvEndp0Data()` API. It is required that the data

buffer passed to receive the data should be placed at a 16-byte aligned location in the DMA buffer RAM. The API will return an error if the buffer placement is not as expected

4. **Send a STALL handshake indicating request handling error:** This option is allowed for all control transfers and is performed by calling the `Cy_USB_USBD_EndpSetClearStall()` API to set the STALL status bit in Endpoint-0

Special control requests

Special callbacks are associated with the `SET_ADDRESS`, `SET_CONFIGURATION` and `SET_INTERFACE` control requests and the `CY_USB_USBD_CB_SETUP` callback is not used for these.

- **SET_ADDRESS:** The **CY_USB_USBD_CB_SETADDR** callback type is used to send notification of the SET_ADDRESS request. No application handling of this request is required as the request would be automatically acknowledged by the USB hardware block. The callback is only provided for information and can be used by the application to identify the type of USB connection which has been established
- **SET_CONFIGURATION:** The **CY_USB_USBD_CB_SET_CONFIG** callback type is used to send notification of the SET_CONFIGURATION request. The application is expected to configure all the endpoints and associated DMA resources before returning from this callback function
- **SET_INTERFACE:** The **CY_USB_USBD_CB_SET_INTF** callback type is used to send notification of a SET_INTERFACE request addressed to any of the interfaces. The interface and alternate setting selected can be retrieved from the setupReq structure in the USB stack context structure. In an application that supports multiple alternate settings for one or more interfaces, this callback is expected to:
  - Disable all endpoints used by the previous alternate setting and free up the corresponding DMA resources
  - Configure and enable all endpoints used by the newly selected alternate setting and configure the corresponding DMA resources

5.3.3 USB operation

Once the USB connection is made and enumeration is complete, the data transfers are mostly handled through the DMA infrastructure and there is no active role for the USB driver stack or API as long as the USB link is in the active state. When there are any USB link power state changes, these get handled by the USB stack and callbacks are raised where applicable to notify the application.

5.3.3.1 USB 2.x power states

The USB 2.0 specification along with updates defined in Engineering Change Notices (ECNs), outlines three power states for the USB link.

- **L0 or Active state:** This is the state in which the USB link remains active and data transfers are supported on the endpoints implemented by the device
- **L2 or Suspend state:** Suspend state is used in the USB 2.x link for power saving. This state is entered when no data (including SOF packets) has been received on the link for more than 3 ms. The state can be exited by >15 MS of resume signaling initiated by the upstream host/hub or by the device (only when remote wakeup is allowed)

  The callback registered for the `CY_USB_USBD_CB_SUSPEND` event is called when the link enters the L2 state and the callback registered for the `CY_USB_USBD_CB_RESUME` event is called when the link resumes into the L0 state

  The `Cy_USBD_SignalRemoteWakeup()` API can be used by the application if there is a need to initiate remote wake from the L2 state. Note that this function will only trigger the remote wake signaling if the operation is permitted by the host controller

- **L1 state:** This is an intermediate low-power state defined through ECN extensions to the USB 2.0 specification. Unlike the L2 state, the entry into the L1 state involves a request from the upstream host/hub which can be acknowledged or rejected by the device

  In the default configuration, the EZ-USB™ FX2G3 USB stack allows acceptance of transition into the L1 state whenever requested by the host/hub. The only exception is that entry into L1 is disabled for a period of 10 ms after the link resumes into L0 state from L1 state. This exception ensures that any pending transfers can be completed before the link returns into the L1 state. The `Cy_USBD_LpmDisable()` API can be used if all transitions into the L1 state are to be unconditionally rejected

  The `CY_USB_USBD_CB_L1_SLEEP` callback is used to notify the application that the USB 2.x link has entered L1 state and the `CY_USB_USBD_CB_L1_RESUME` callback for notification of the link resuming into L0 state. As in the case of the L2 state, the `Cy_USBD_SignalRemoteWakeup()` API can be used by the application to initiate exit from the L1 state into the L0 state

5.3.4 USB disconnection and reconnection

If the EZ-USB™ FX2G3 application has a requirement to break the active USB connection, call the `Cy_USBD_DisconnectDevice()` API. It is recommended that the USB PHY and controller blocks are disabled after the disconnection. When a new connection is desired, call the `Cy_USBD_ConnectDevice()` API again as described in Section 5.3.1.

5.4 Sensor Interface Port (SIP) operation

The Sensor Interface Port (SIP) on the EZ-USB™ FX2G3 device is used to connect to an external data source or sink such as an FPGA or image sensor. The SIP supports an LVCMOS interface.

5.4.1 Sensor interface initialization

The LVCMOS_LVDS block is initialized and configured using the LVCMOS/LVDS library which is a part of the USBFXStack middleware library.

Configuring the SIP/LVCMOS_LVDS on the EZ-USB™ FX2G3 device involves multiple stages as follows:

1. **Controller and PHY configuration:** The operating mode for the SIP controller is selected and the respective PHY blocks are enabled. This stage is performed by calling the `Cy_LVDS_Init()` API. The parameters provided through the **lvdsConfig** > **phyConfig** structure are used for the PHY initialization

Table 5 Sensor interface parameters

Parameter	Type	Description
`wideLink`	Boolean	Set to false for EZ-USB™ FX2G3 as EZ-USB™ FX2G3 supports only 16-bit bus width
`modeSelect`	Enumeration	Should be set only to `CY_LVDS_PHY_MODE_LVCMOS`. This selects LVCMOS operation. Other modes are unsupported on the EZ-USB™ FX2G3 device
`dataBusWidth`	Enumeration	Selects the number of data lanes: 8 or 16 for LVCMOS
`interfaceClock`	Enumeration	Expected interface clock frequency
`gearingRatio`	Enumeration	Should be set to `CY_LVDS_PHY_GEAR_RATIO_1_1` as EZ-USB™FX2G3 only supports SDR operation

Parameter	Type	Description
`clkSrc`	Enumeration	Select the clock used for the data link and GPIF operation: Select from between interface clock, 480 MHz clock derived from USB2 (USB-HS) block
`clkDivider`	Enumeration	Select the division factor that is used to reduce the frequency of the clock used for data link and GPIF operation. The maximum clock frequency supported for link and GPIF operation is 240 MHz. When the clkSrc is selected as USB2, it needs to be divided at least by 2 to reduce the frequency to a valid range
`phyTrainingPattern`	uint8_t	Not applicable for EZ-USB™ FX2G3
`linkTrainingPattern`	uint32_t	Not applicable for EZ-USB™ FX2G3
`ctrlBusBitMap`	uint32_t	Specifies the LVCMOS control signals associated with the link which should be enabled as input pins. The init code will only enable the input buffers for the pins which have been selected here
`loopbackModeEn`	bool	Not applicable for EZ-USB™ FX2G3. Must be set as false
`isPutLoopbackMode`	bool	Not applicable for EZ-USB™ FX2G3. Must be set as false
`slaveFifoMode`	Enumeration	EZ-USB™ FX2G3 supports 2-bit Slave FIFO operation
`dataBusDirection`	Enumeration	Specifies whether the data bus which is part of the link is being used in input only, output only or bi-directional modes
`lvcmosClkMode`	Enumeration	Specifies whether the interface clock is input to the EZ-USB™ FX device or output from it. Output mode is only supported in LVCMOS configuration
`lvcmosMasterClkSrc`	Enumeration	Specifies the source of the interface clock in cases where it is being output by the EZ-USB™ FX device

2. **GPIF state machine initialization:** The SIP data link operation on the EZ-USB™ FX2G3 device is governed by the General Programmable Interface (GPIF) block. The GPIF state machine specifies the sequence based on which the data is either sampled from the interface or driven on the interface. The GPIF state machine is configured by the `Cy_LVDS_Init()` function and then enabled using the `Cy_LVDS_GpifSMStart()` function

5.5 GPIF state machines

As the LVCMOS interface of the EZ-USB™ FX2G3 device are expected to be driven by an FPGA, use a set of standard pre-defined configurations for the GPIF state machines. The following sub-sections document the standard GPIF configurations and interfaces used in the various EZ-USB™ FX2G3 code examples.

5.5.1 GPIF config for LVCMOS receiver application

The *mtb-example-fx2g3-slave-fifo-in* and *mtb-example-fx2g3-uvc-uac* applications use the 2-bit Slave FIFO interface. This is a standard LVCMOS configuration which allows the FPGA master to select and perform data transfers to one out of two different pipes. A two-bit address bus is used to select the active pipe for transfer and control signals are used to enable sending of full-length packets, short-length packets, and zero-length packets. The code examples support two LVCMOS sockets using 2-bit address input. As only two threads/pipes are accessible in the device, the MSB of a 2-bit address should always be ‘0’.

GPIF state machine

Figure 17 shows the state machine used by this LVCMOS receiver and transmitter implementation. The state machine simply samples/drives the data on the LVCMOS data lanes based on the control signals and write/read into/from the DMA buffer when the DMA buffers are ready to accept/send the data.

The thread and socket selection in this application are done through the A[0:1] address lines driven by the master/FPGA. Before the master sends data into any thread, it is expected to verify that the corresponding DMA_RDY (Flag A) signal is being asserted (low) by the EZ-USB™ FX2G3 device.

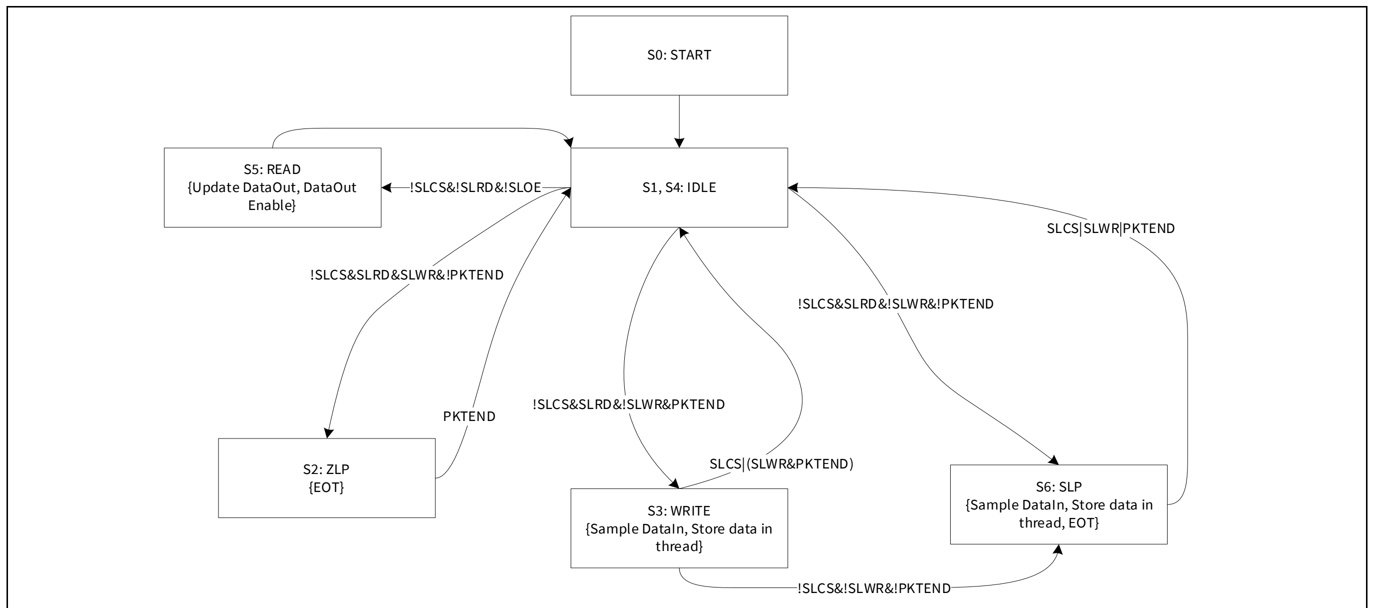

Figure 17 GPIF state machine used by 2-bit Slave FIFO application

Interface signals

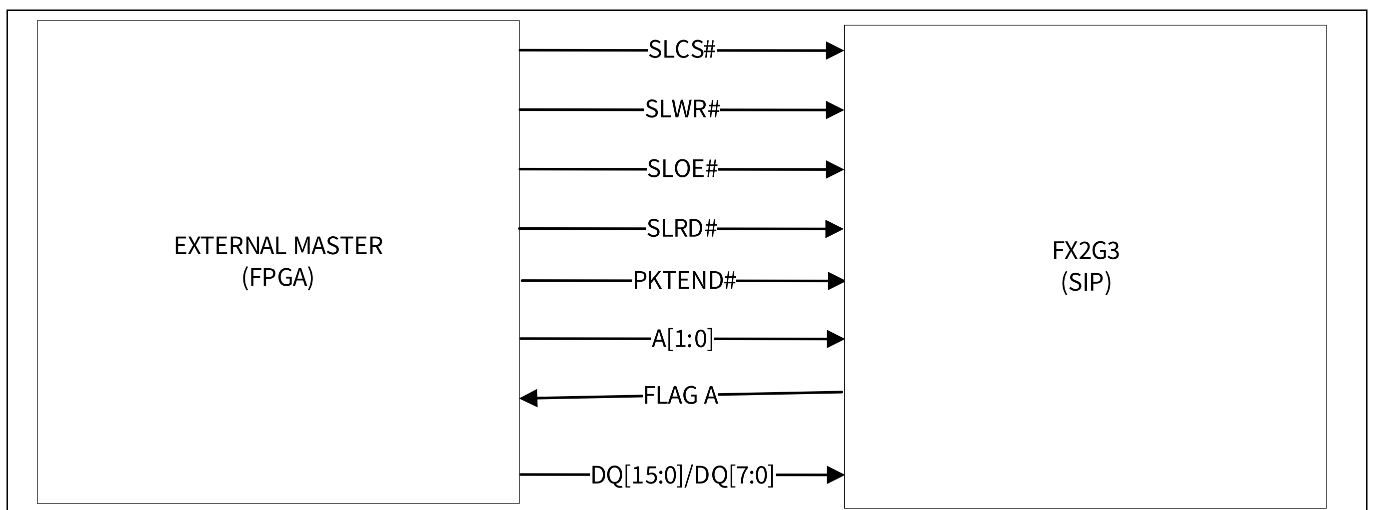

Figure 18 Control signal usage in LVCMOS receiver state machine

Table 6 Control signal usage in LVCMOS 2-bit Slave FIFO state machine

EZ-USB™ FX2G3 pin	Function	Description
P0CTL0 (A35)	SLCS#	Active LOW Chip Select signal. Should be asserted (LOW) by the master FPGA when communicating with EZ-USB™ FX2G3
P0CTL1 (A2)	SLWR#	Active LOW Write Enable signal. Should be asserted (LOW) by the master FPGA when sending any data to the EZ-USB™ FX2G3. The data present on the data lanes will be sampled and stored into the DMA buffer when this signal is asserted along with SLCS# Can be combined with the PKTEND# signal to indicate that this data ends the transfer, and the DMA operation should be terminated
P0CTL2 (A1)	SLOE#	Active LOW Output Enable signal
P0CTL3 (A37)	SLRD#	Active LOW Read Enable signal. Not used in this application as data is only being received by EZ-USB™ FX2G3
P0CTL4 (A38)	PKTEND#	Active LOW Packet End signal. Should be asserted (LOW) when the FPGA master wants to terminate the ongoing DMA transfer. Should be asserted along with SLWR# and the last cycle of data to complete transfers with non-empty data. Can be asserted only when SLCS# is LOW and SLWR# is HIGH to complete the DMA transfer with zero bytes of data
P0CTL5 (A29)	Flag A	Active LOW DMA ready indication for the currently addressed or active thread
P0D8 (A45)	A0	LS bit of 2-bit address bus used to select the thread (applicable for 8-bit LVCMOS bus width)
P0D9 (A46)	A1	MS bit of 2-bit address bus used to select thread (applicable for 8-bit LVCMOS bus width)
P1CTL9 (A31)	A0	LS bit of 2-bit address bus used to select thread (applicable for 16-bit LVCMOS bus width)
P1CTL8 (A30)	A1	MS bit of 2-bit address bus used to select thread (applicable for 16-bit LVCMOS bus width)

Table 7 GPIOs for configuring FPGA on KIT_FX2G3_104LGA DVK

EZ-USB™ FX2G3 Pin	Function	Description
GPIO5 (B38)	CDONE#	Active HIGH signal. FPGA asserts when FPGA configuration is completed
GPIO6 (B39)	INIT#_RESET	Active LOW signal. EZ-USB™ FX2G3 asserts to reset the FPGA

5.6 DMA datapath operation

Once all the required hardware blocks on EZ-USB™ FX2G3 have been initialized and the USB connection has been enabled, the data flow through the USB endpoints is handled through DMA acceleration with minimal firmware intervention.

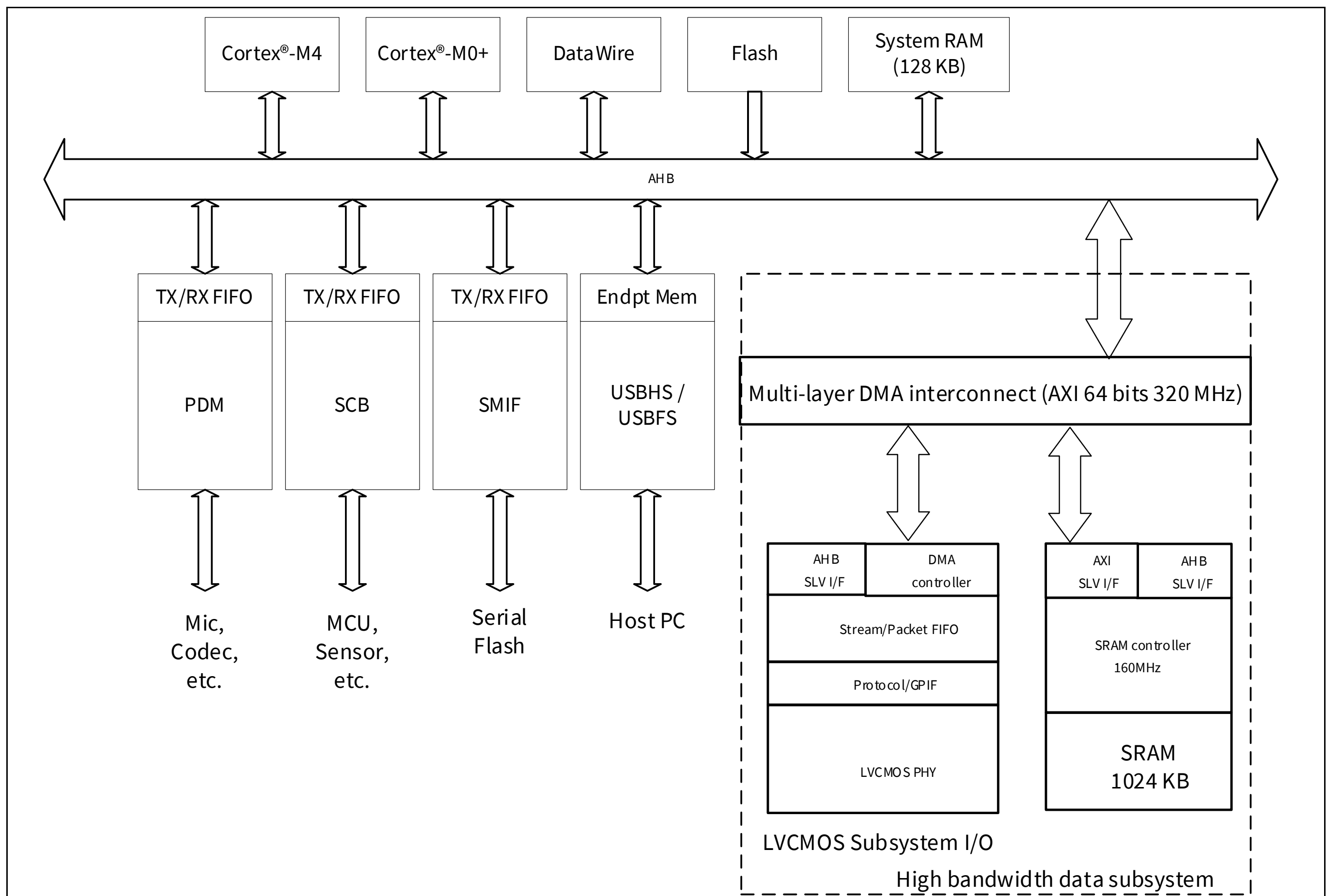

Figure 19 Datapaths within EZ-USB™ FX2G3 device

The EZ-USB™ FX2G3 device supports two different DMA frameworks:

- AXI-based high-speed DMA framework which is part of the High BandWidth subsystem which moves data between the Sensor Interface Port (SIP) and the SRAM. This DMA framework is similar to the one used on the EZ-USB™ FX3 device and the SDK provides a similar set of API to configure and manage these data transfers
- AHB-based DataWire DMA framework which can move data between all on-chip memories as well as the legacy peripherals such as the USBHS block, USBFS block, SCB, SMIF, PDM block, and I2S block

The scope of each of these DMA data paths is shown in Figure 19.

The High BandWidth DMA framework can only move data in and out of the SIP and can only access the dedicated DMA buffer RAM. This means that any data to be sent through the LVCMOS first needs to be copied into the DMA buffer RAM and then the DMA initiated. Similarly, any data received through the LVCMOS interface has to be collected in the DMA buffer RAM and then copied elsewhere as needed.

The DataWire DMA framework can access all memories and peripherals which are connected to the system-wide Advanced High-performance Bus (AHB) including the flash memory, system as well as DMA buffer RAM and other peripherals.

Both types of DMA are required when the EZ-USB™ FX2G3 device transfers data received through the LVCMOS interface to the USB host PC through the USB connection. The High BandWidth DMA copies the data from the SIP into the buffer RAM and DataWire sends the received data to the USBHS block.

5.6.1 High BandWidth DMA (HBDma) programming

HBDma is initialized and configured using the DMA manager USBFXStack middleware library.

All data movement within the High BandWidth subsystem happens through temporary buffers located in the buffer RAM. When a DMA datapath is being set up between the LVCMOS and USBHS interfaces, the firmware needs to prepare RAM buffers which will be used for the transfers and configure a set of descriptors which track the state of these RAM buffers. This is performed using a set of convenience API provided as part of the High BandWidth DMA manager.

5.6.1.1 HBW DMA manager initialization

Before the High BandWidth DMA manager can be used, perform the following for initialization:

1. Initialize the DMA adapter blocks that are associated with the Sensor Interface Port. This is done by calling the `Cy_HBDma_Init()` API
2. Initialize a free pool of DMA descriptors for use by the DMA manager. The maximum number of DMA descriptors which can be used at any one time needs to be specified as a parameter and it is recommended that this value be set to at least 512 descriptors. As each descriptor occupies 16 bytes of memory, enabling the free pool to use 512 descriptors reserves the first 8 KB of the buffer RAM for DMA descriptor usage. The `Cy_HBDma_DscrList_Create()` API is used to initialize this descriptor free pool
3. Initialize the DMA buffer manager that performs the dynamic memory allocation of all RAM buffers required for the various High BandWidth DMA datapaths. The allocation scheme used is a custom one which ensures that all buffers allocated are placed at 64-byte aligned RAM locations and is designed to have a fixed memory allocation overhead. The `Cy_HBDma_BufMgr_Create()` API is used to initialize the buffer manager and the start address and size of the RAM based heap region need to be passed as parameters
4. Initialize the HBDma manager module itself by calling the `Cy_HBDma_Mgr_Init()` API
5. There is one DMA adapter interrupt source for which an interrupt handler needs to be registered:
   a) **lvds2usb32ss_lvds_dma_adap0_int_o_IRQn:** Corresponds to interrupts associated with any of the first 16 DMA sockets in the SIP (effectively DMA interrupts associated with LVDS link #0). The ISR for this interrupt needs to call the `Cy_HBDma_HandleInterrupts()` function with the adapter parameter set to a value of **CY_HBDMA_ADAP_LVDS_0**

5.6.1.2 HBW DMA channel functions

A High BandWidth DMA channel is a virtual construct which binds all resources associated with a single data path through the AXI bus. The resources include the sockets (pipes) on the LVCMOS side where the data enters or exits the EZ-USB™ FX2G3 DMA framework, the RAM buffers which are used for temporary storage of the data and the corresponding descriptors which store the location and state information about the RAM buffers.

A socket represents one end of a data stream which flows through the AXI DMA framework. There is dedicated logic associated with each socket which keeps track of the state of the ongoing data transfer. Sockets through which data enters the EZ-USB™ FX2G3 device are called “Producer” or “Ingress” sockets. Sockets through which data exits the EZ-USB™ FX2G3 device are called “Consumer” or “Egress sockets”.

The following channel can be created:

- IP to memory channels, which receive data through the LVDS/LVCMOS interface and store it in memory. In this case, the channel will only have valid producer sockets
- Memory to IP channels which take data from memory and send it out through the LVCMOS interface. In this case, the channel will only have valid consumer sockets

A set of convenience APIs is provided in the SDK for the creation, management, and operation of these DMA channels. A summary of the APIs is provided in Table 8.

Table 8 DMA channel APIs

DMA manager API	Description
`Cy_HBDma_Channel_Create`	Creates a DMA channel structure based on the parameters specified in the configuration structure The channel create API allocates the required number of RAM buffers and descriptors, initializes them and configures the sockets through which data enters/exits the EZ-USB™ FX2G3 device The channel is not ready for data transfer when this function returns and explicitly needs to be enabled
`Cy_HBDma_Channel_Destroy`	Destroys the DMA channel structure and frees up all resources used for its operation. The sockets used by this DMA channel will be left in the disabled state
`Cy_HBDma_Channel_Enable`	Enables a DMA channel to move the specified amount of data (can be infinite data as well). The sockets associated with the channel are only enabled when this API is called
`Cy_HBDma_Channel_Disable`	Disables a DMA channel and restores it into the idle state which is equivalent to the state immediately after channel creation
`Cy_HBDma_Channel_Reset`	This function is equivalent to `Cy_HBDma_Channel_Disable`
`Cy_HBDma_Channel_GetBuffer`	This function is used to retrieve information about the active RAM buffer associated with the DMA channel. In the case of IP to IP and IP to Memory DMA channels, the API will only return a valid buffer if data is present in the buffer and yet to be processed. In the case of a Memory to IP channel, the API will return a valid buffer if it is empty and firmware can fill it with new data
`Cy_HBDma_Channel_CommitBuffer`	This function is used in the case of IP to IP and Memory to IP DMA channels to enable sending of data in a RAM buffer through the output path (consumer socket)
`Cy_HBDma_Channel_DiscardBuffer`	This function is used in the case of IP to IP and IP to Memory DMA channels to discard data which has been received through the input path (producer socket)

The HBDma manager can generate callback notifications when events of interest occur on either the producer or consumer sockets associated with a channel. The `CY_HBDMA_CB_PROD_EVENT` notification indicates that a RAM buffer has been filled with data received through the producer socket and is ready for firmware processing or forwarding to the consumer socket. The `CY_HBDMA_CB_CONS_EVENT` notification that a RAM buffer has been freed up because the data present in it has been sent out through the consumer socket. It is possible for firmware to return this buffer to the use of the producer socket so that new data can be written into it.

IP to memory and memory to IP channels require firmware intervention at the granularity of each DMA buffer. The callback notifications listed above can be used to trigger the appropriate API calls to forward or discard the data associated with the channel.

5.6.2 DataWire DMA programming

DataWire DMA controllers are initialized & configured using the mtb-pdl-cat1 PDL.

The EZ-USB™ FX2G3 device supports two instances of DataWire DMA controller each of which supports 24 channels. Each DataWire DMA channel is capable of moving data from a peripheral block or memory region to another peripheral block or memory region.

Unlike the High BandWidth DMA, the DataWire DMA does not understand USB packet boundaries and moves the user-specified amount of data. The DataWire DMA operation can be started/continued automatically based on trigger signals generated from peripheral blocks and connected to the DataWire DMA controller through a set of Trigger Multiplexers (TrigMux).

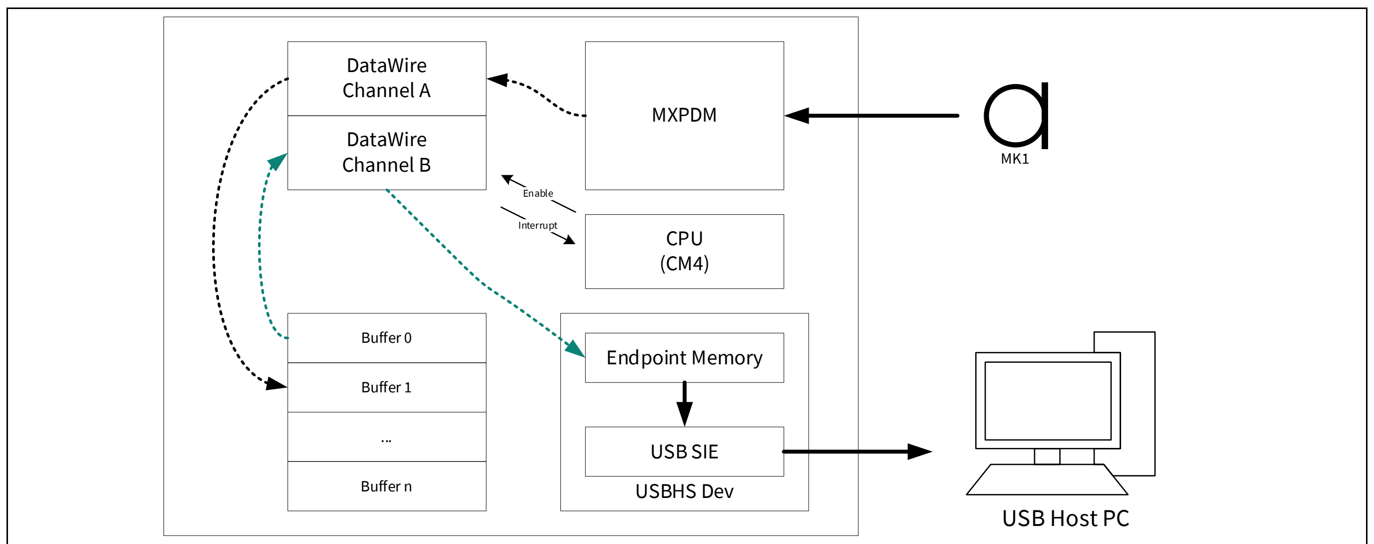

Figure 20 PDM microphone to USBHS transfer using DataWire

Figure 20 shows the data flow in a case where data received from a PDM microphone is transferred to USBHS IN endpoint as part of a USB Audio implementation.

While DataWire supports direct transfer from PDM FIFOs to the USB endpoint memory, this is not recommended for use because each DataWire channel can only take a single trigger input. Because of this constraint, it is not possible to configure the channel to perform a transfer only in cases where the PDM FIFO has data and the endpoint memory has free space.

Two DataWire channels are used to address this restriction:

- **Channel A** is used to transfer data from the received FIFOs in the PDM IP block to RAM buffers. This transfer is triggered whenever the FIFO has a specific amount of data available
- **Channel B** is used to transfer data from the RAM buffers into the USB IN endpoint memory region for transfer to the USB host. This transfer is triggered whenever the endpoint memory has free space to hold one data packet

Firmware-based control is required to manage the sequencing of the two DataWire channel operations. For example, Channel A should only be enabled for transfer if a free RAM buffer is available to hold the received data. Similarly, channel B should only be enabled when a RAM buffer has been filled with data received from the microphone.

5.6.2.1 DataWire channel mapping

DataWire channels do not have any restrictions with respect to the source and destination data regions used. This means that any DataWire channel can use any memory region, register set, or hardware FIFO, which is accessible through the AHB as source or destination for the DMA transfers (subject to target level read/write capabilities; for example, flash memory cannot be used as destination as the memory is not directly writeable).

However, there are restrictions with respect to the triggers which can be connected to/from each of the DataWire channels. Due to these constraints, there is a recommended usage mapping for the DataWire channels supported on the EZ-USB™ FX2G3 as shown in Table 9. If any of the recommended transfers are not in use in a given application, the respective channel can be used for other purposes.

USB Endpoint#0 uses DMAC channels 0 and 1 for data transfers as DMAC channels give more flexibility.

Table 9 Recommended usage mapping for DataWire/DMAC channels

DataWire-0/DMAC channel	Function	DataWire-1/DMAC channel	Function
DMAC: Channel 1	Read from USBHS OUT Endpoint #0	DMAC: Channel 0	Write to USBHS IN Endpoint #0
DW0: Channel 1	Read from USBHS OUT Endpoint #1	DW1: Channel 1	Write to USBHS IN Endpoint #1
DW0: Channel 2	Read from USBHS OUT Endpoint #2	DW1: Channel 2	Write to USBHS IN Endpoint #2
…	–	…	–
DW0: Channel 14	Read from USBHS OUT Endpoint #14	DW1: Channel 14	Write to USBHS IN Endpoint #14
DW0: Channel 15	Read from USBHS OUT Endpoint #15	DW1: Channel 15	Write to USBHS IN Endpoint #15
DW0: Channel 16	Write to SCB0 TX FIFO	DW1: Channel 16	Write to SCB2 TX FIFO
DW0: Channel 17	Read from SCB0 RX FIFO	DW1: Channel 17	Read from SCB2 RX FIFO
DW0: Channel 18	Write to SCB1 TX FIFO	DW1: Channel 18	Write to SCB3 TX FIFO
DW0: Channel 19	Read from SCB1 RX FIFO	DW1: Channel 19	Read from SCB3 RX FIFO
DW0: Channel 20	Write to SMIF TX FIFO	DW1: Channel 20	Read from PDM RX FIFO #0
DW0: Channel 21	Read from SMIF RX FIFO	DW1: Channel 21	Read from PDM RX FIFO #1
DW0: Channel 22	Write to I2S TX FIFO	DW1: Channel 22	Read from CANFD RX FIFO #0
DW0: Channel 23	Read from I2S RX FIFO	DW1: Channel 23	Read from CANFD RX FIFO #1

5.6.2.2 DataWire transfers

Typical DataWire transfers can be configured as 1-D transfers or 2-D transfers. In both cases, the channel can transfer a specific amount of data on receiving a trigger signal. The channel can also generate an output trigger or raise an interrupt to the device CPU core when a specific amount of data has been transferred.

- DataWire transfers are configured using the `Cy_DMA_Channel_Init()` API and enabled using the `Cy_DMA_Channel_Enable()` API
- Details of the transfer to be performed are to be set in a RAM-based descriptor structure using the `Cy_DMA_Descriptor_Init()` API

Separate interrupt vectors are associated with each DataWire channel and corresponding ISRs can be registered and used. There is no recommended handling required for any of the DataWire channel interrupts.

5.6.2.3 DataWire wrapper functions for USBHS

A set of convenience wrapper APIs have been provided to configure and manage DataWire-based transfers from/to the Endpoint Memory block in the USB Hi-Speed peripheral block.

- The `Cy_USBHS_App_EnableEpDmaSet()` API is used to set up the DataWire DMA resources required to read/write data to the USBHS endpoints to/from RAM-based buffers. This API also sets up the relevant trigger connections for these transfers
- The `Cy_USBHS_App_DisableEpDmaSet()` is used to free up these DMA resources and break previously created trigger connections
- The `Cy_USBHS_App_QueueRead()` function is used to queue a DataWire based read operation to read one or more packets of data from the Endpoint Memory region corresponding to an OUT endpoint. It is expected that the data size specified is an integral multiple of the maximum packet size for the endpoint. Typically, the read operation will be queued even before any data has been received from the host controller so that the shared endpoint memory buffers are drained as soon as they are filled
- DataWire channels move data based on a pre-configured transfer size. When a short packet is received on the OUT endpoint, the channel needs to be re-configured based on the actual size of data in the packet. Otherwise, there will be an underrun condition when the DataWire tries to read more data than is actually available in the Endpoint Memory
- The `Cy_USBHS_App_ReadShortPacket()` API is used to re-configure the DataWire channel to read the actual amount of data present in the short packet which has been received. The function will return the complete transfer size including any full data packets which were previously received and transferred using the DataWire channel
- The `Cy_USBHS_App_QueueWrite()` API is used to start writing one or more packets of data to the Endpoint Memory region corresponding to an IN endpoint. There are no restrictions on the data size and the transfer will be completed with a short packet where applicable

5.7 DMA transfer use cases

5.7.1 LVCMOS to USBHS data transfer

In this case, you need to use a High BandWidth DMA channel to copy the data from the LVDS IP into the DMA buffer RAM and a DataWire channel to move the data to the USBHS endpoint memory.

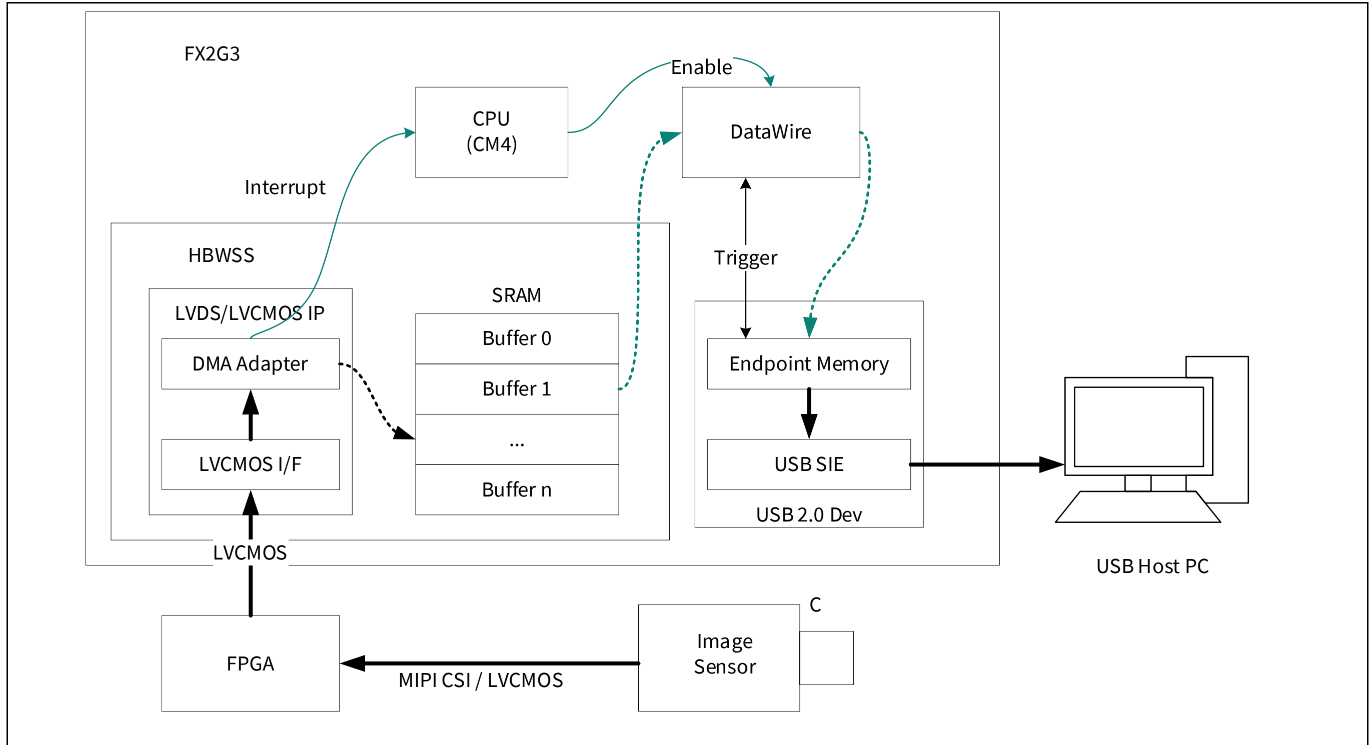

Figure 21 LVCMOS to USBHS data transfer

The produce event callbacks from the High BandWidth DMA channel are used to enable DataWire transfers to the USBHS endpoints. Once the DataWire transfer completion interrupt is received, the High BandWidth DMA buffers are marked free by calling the `Cy_HBDma_Channel_DiscardBuffer()` API.

5.7.2 PDM to USBHS data transfer

In this case, the transfer is done by using only DataWire channels. The data flow is shown in Figure 21; the transfer handling is described in Section 5.6.2.

6 Slave FIFO IN code example overview

This chapter provides a comprehensive guide for understanding, using and customizing the Slave FIFO IN code example. It covers the complete data flow from external FPGA/master through the EZ-USB™ FX2G3 device to USB host, endpoint configuration, DMA architecture and step-by-step customization guidance.

6.1 Overview

6.1.1 Slave FIFO

The Sensor Interface Port (SIP) of the EZ-USB™ FX2G3 device is configured and used to implement the Infineon-defined Slave FIFO protocols allowing an external master device (typically an FPGA) to read or write data directly from or into the EZ-USB™ FX2G3 device's internal FIFO buffers. The EZ-USB™ FX2G3 device acts as a slave, i.e., it does not initiate transfers but responds to the master's read/write requests.

6.1.1.1 Features

- **Synchronous Operation:** All transfers are synchronized to an external clock provided by the master
- **High Bandwidth:** Supports up to 480 Mbps (USB 2.0 High-Speed)
- **Direct Memory Access:** The High-BandWidth DMA subsystem allows data flow with minimal CPU intervention: LVCMOS interface → HBW SRAM, and HBW SRAM → USB
- **GPIF III State Machine:** Programmable interface handles protocol timing automatically

6.1.2 Slave FIFO IN vs OUT vs IN-OUT (Bidirectional)

Mode	Direction	Description	Code example
Slave FIFO IN	FPGA → EZ-USB™ FX2G3 → Host	Master writes data to EZ-USB™ FX2G3, Host reads FROM EZ-USB™ FX2G3	mtb-example-fx2g3-slave-fifo-in
Slave FIFO OUT	Host → EZ-USB™ FX2G3 → FPGA	Host writes data to EZ-USB™ FX2G3, Master reads FROM EZ-USB™ FX2G3	mtb-example-fx2g3-slave-fifo-out
Slave FIFO IN-OUT	Both directions	Combines IN and OUT in single application	mtb-example-fx2g3-slave-fifo-in-out

Note: This chapter focuses on Slave FIFO IN code example. The same concepts apply to Slave FIFO OUT with reversed data direction.

6.2 Architecture overview

6.2.1 System block diagram

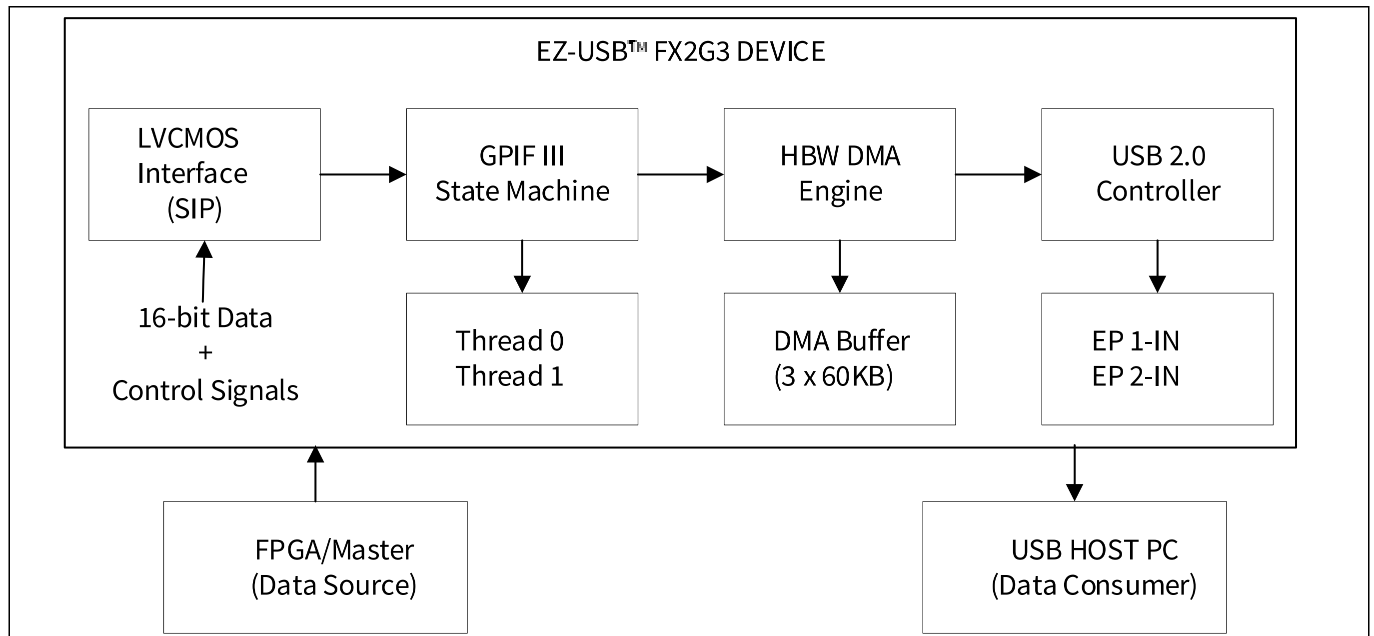

Figure 22 System block diagram

6.2.2 Data flow path

The data flows through these stages:

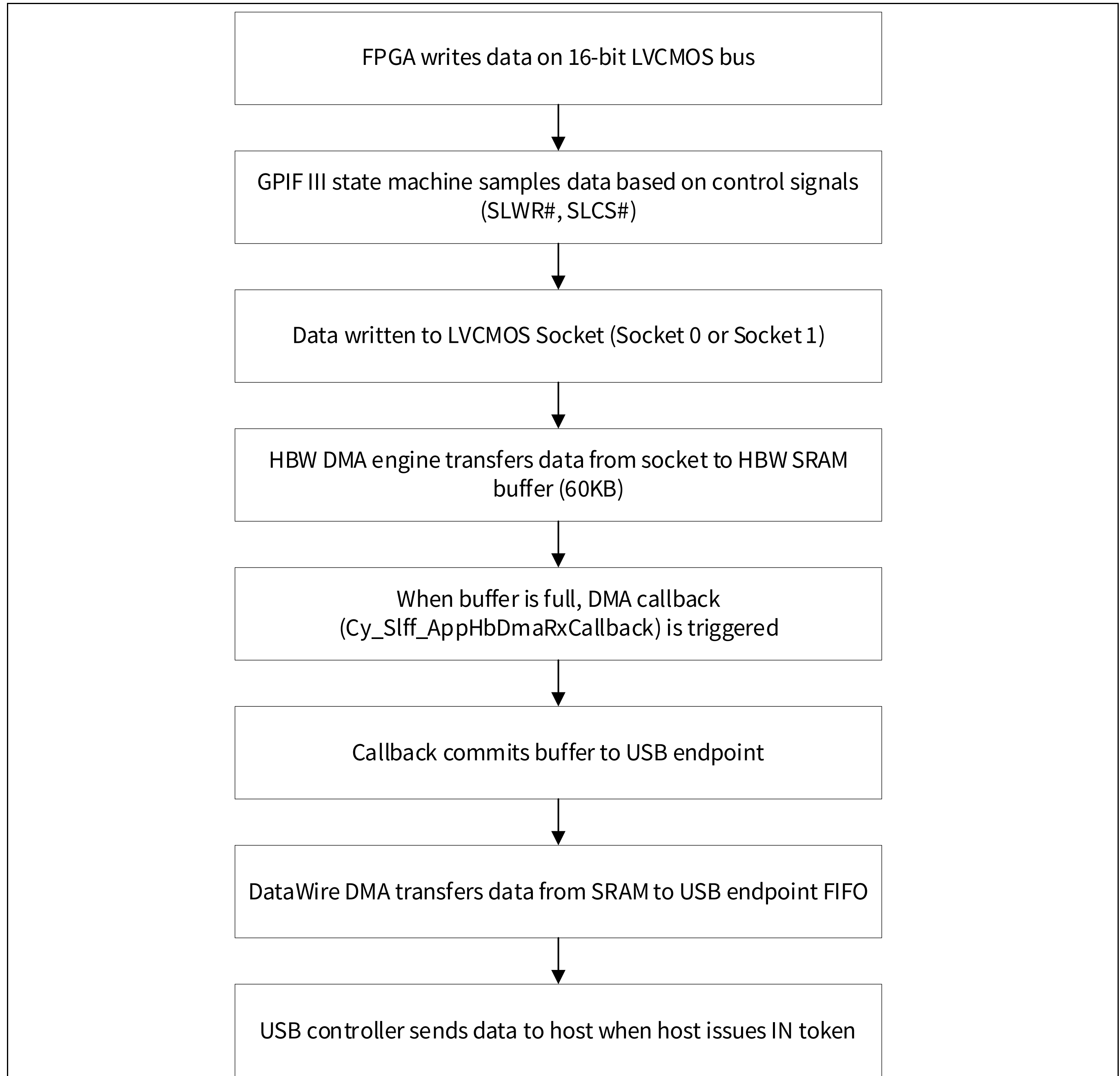

Figure 23 Data flow path

6.2.3 Thread-to-Socket-to-Endpoint Mapping

The code example uses the following mapping in its default configuration:

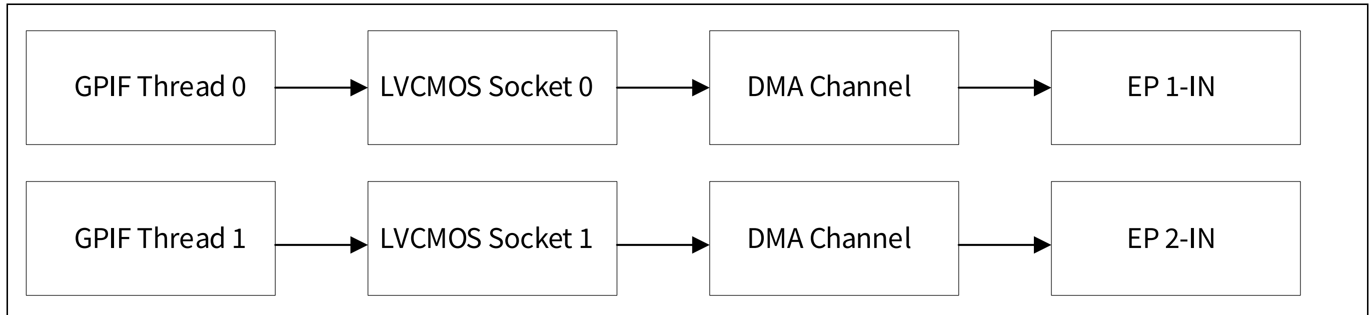

Figure 24 Default configuration mapping

Table 10 Address lines and selected thread

Address Lines (A1:A0)	Selected Thread
00	Thread 0 (writes to Socket 0 → EP 1-IN)
01	Thread 1 (writes to Socket 1 → EP 2-IN)
10	Reserved
11	Reserved

6.3 Endpoint Configuration

6.3.1 EZ-USB™ FX2LP vs. EZ-USB™ FX2G3 Endpoint Addressing

The endpoint addressing scheme has changed significantly from FX2LP to EZ-USB™ FX2G3.

EZ-USB™ FX2LP Addressing (Legacy):

In EZ-USB™ FX2LP, the endpoint number included the direction bit:

- EP2-OUT = **0x02** (direction bit = 0 for OUT)
- EP6-IN = **0x86** (direction bit = 1 for IN, so 0x80 | 0x06 = 0x86)

EZ-USB™ FX2G3 Addressing (New):

In EZ-USB™ FX2G3, the endpoint number and direction are separate parameters:

- **Endpoint number**: Just the number (1-15), example. 6, for endpoint 6-OUT or 6-IN
- **Direction**: Specified separately via **CY_USB_ENDP_DIR_IN** or **CY_USB_ENDP_DIR_OUT**

Table 11 Example endpoint notations

What you want	EZ-USB™ FX2LP notation	EZ-USB™ FX2G3 notation
Endpoint 1 IN	0x81	Endpoint = 1, Direction = IN
Endpoint 2 OUT	0x02	Endpoint = 2, Direction = OUT
Endpoint 6 IN	0x86	Endpoint = 6, Direction = IN
Endpoint 8 OUT	0x08	Endpoint = 8, Direction = OUT

6.3.2 Endpoint selection

Endpoints are set in the USB descriptors based on the configurable Endpoint Macros. To select a different endpoint for the project, simply change the value of the corresponding endpoint macro.

6.3.2.1 USB Descriptors (usb_descriptors.c)

```
/* File: usb_descriptors.c */
/* Endpoint descriptor for consumer EP */
0x07,                       /* Descriptor size */
0x05,                       /* Endpoint descriptor type */
0x80 | BULK_IN_ENDPOINT_1,  /* Endpoint address: 0x80 = IN direction, ORed with endpoint number */
0x02,                       /* Bulk endpoint type */
0x00,0x02,                  /* Max packet size = 512 bytes (High-Speed) */
0x00,                       /* Servicing interval: 0 for Bulk */
```

- **Byte 3 (0x80 | BULK_IN_ENDPOINT_1)**: The 0x80 sets the IN-direction bit. BULK_IN_ENDPOINT_1 is defined as 0x01, so the result is 0x81 (EP1-IN)
- **To change to EP6-IN**: Set the **BULK_IN_ENDPOINT_1** Endpoint Macro to **0x06**, descriptor becomes **0x86**

6.3.2.2 Endpoint Macros (usb_app.h)

```
/* File: usb_app.h */
/* Select the primary BULK-IN endpoint used for data streaming.
 * The direction bit does not need to be set and the value should be between 1 and 15 */
#define BULK_IN_ENDPOINT_1          (0x01)
/* Select the secondary BULK-IN endpoint used for data streaming when DEVICE1_EN is set to 1.
 * The direction bit does not need to be set and the value should be between 1 and 15 */
#define BULK_IN_ENDPOINT_2          (0x02)
```

- BULK_IN_ENDPOINT_1 = The endpoint NUMBER only (1-15)

6.3.2.3 DMA Channel Creation (usb_app.c)

```
/* File: usb_app.c */
if (endpNumber == BULK_IN_EP1_INDEX) {
  /* ... DMA configuration ... */
  dmaConfig.consSck[0] = (cy_hbdma_socket_id_t)(CY_HBDMA_USBHS_IN_EP_00 + endpNumber);
  /* ... */
}
```

DMA Socket Mapping:

- CY_HBDMA_USBHS_IN_EP_00 is the base socket ID for USB HS IN endpoints
- Adding endpNumber gives the socket for that specific endpoint
- Example: EP6-IN → CY_HBDMA_USBHS_IN_EP_00 + 6 = Socket for EP6

6.3.3 Endpoint-to-DMA Channel Mapping

The EZ-USB™ FX2G3 device supports a total of 48 DataWire DMA channels which move data between on-chip peripherals and memories. 32 of these channels are reserved for moving data between the USB endpoint FIFOs and memories: 16 channels used for copying data from the USB OUT endpoint FIFOs into RAM buffers and 16 channels used for copying data from RAM buffers into USB IN endpoint FIFOs.

An implicit 1:1 mapping between USB endpoints and the DMA channels is maintained by the USBFXStack library. The channel ID to be used for data transfer from USB OUT endpoints should be selected from CY_HBDMA_USBHS_OUT_EP_00 to CY_HBDMA_USBHS_OUT_EP_15 based on the endpoint index. Similarly, the channel ID to be used for data transfer into USB IN endpoints should be selected from CY_HBDMA_USBHS_IN_EP_00 to CY_HBDMA_USBHS_IN_EP_15.

6.3.4 Application Data Structure

The Slave FIFO IN application uses a cy_stc_usb_app_ctxt_t structure to encapsulate the state of the device and firmware modules.

This structure includes a pair of endpInDma and endpOutDma arrays to hold the DMA information associated with the IN and OUT endpoints.

```
/* File: usb_app.h */

/* Data-path status for IN endpoints */

cy_stc_app_endp_dma_set_t endpInDma[CY_USB_MAX_ENDP_NUMBER];

/* Data-path status for OUT endpoints */

cy_stc_app_endp_dma_set_t endpOutDma[CY_USB_MAX_ENDP_NUMBER];
```

It also includes a pair of pointers to the DMA channels used for the two data streams from LVCMOS to USB. These store references to the DMA channel structures for quick access during streaming.

```
/* File: usb_app.h */

/* Pointers to the primary and secondary DMA channels */

cy_stc_hbdma_channel_t *hbBulkInChannel[2];


/* File: usb_app.c */

/* Store the DMA channel pointer */

pUsbApp->hbBulkInChannel[0] = &(pUsbApp->endpInDma[endpNumber].hbDmaChannel);
```

- endpInDma[] is an array of DMA structures, indexed by endpoint number
- When you use endpoint 6, the DMA channel structure from endpInDma[6] is used
- The hbBulkInChannel[0] pointer stores a reference to the channel for quick access during streaming

Table 12 Endpoint To Dma Mapping Architecture

Endpoint Number	endpInDma[] Index	hbBulkInChannel[] Index
1	endpInDma[1]	hbBulkInChannel[0]
2	endpInDma[2]	hbBulkInChannel[1]
6	endpInDma[6]	hbBulkInChannel[0]*

*Note: If you change primary endpoint from 1 to 6

6.4 GPIF III State Machine

6.4.1 Overview

GPIF III (General Programmable Interface III) is a configurable state machine that controls the timing and protocol of data transfers on the LVCMOS interface. The GPIF III Designer tool can be used to configure the state machines governing the LVCMOS interface.

- Monitors control signals from the FPGA (SLWR#, SLCS#, PKTEND#, etc.)
- Generates response signals (FlagA for DMA ready)
- Triggers DMA transfers when data is available
- Handles thread selection based on address lines (A1:A0)

6.4.2 GPIF State Machine States

The Slave FIFO IN state machine has 7 states with transitions as follows:

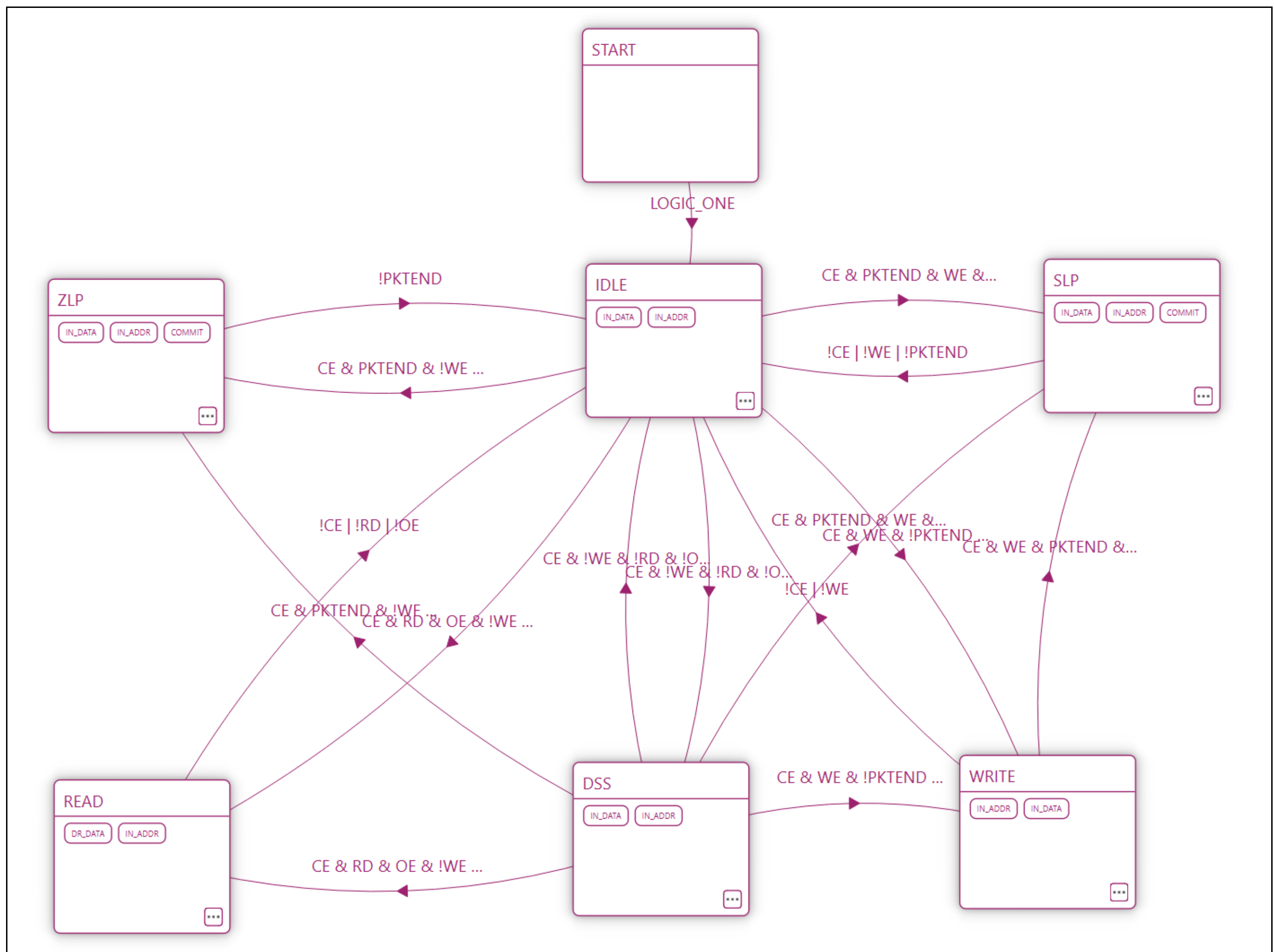

Figure 25 GPIF State Machine for Slave FIFO IN

Table 13 State descriptions

No	Name	Description
0	START	Initial state after reset
1	IDLE	Waiting for master to initiate transfer
2	READ	Reading data from master (not used in FIFO-IN)
3	WRITE	Master is writing data to EZ-USB™ FX2G3
4	SLP	Short packet handling
5	ZLP	Zero-length packet handling
6	DSS	Data streaming state

Table 14 Signal descriptions

Symbol	Type	Description
SLCS#	Chip Select	Active LOW. Must be asserted for any communication
SLWR#	Write Enable	Active LOW. Data is sampled on rising edge of CLK when LOW

Symbol	Type	Description
FlagA#	DMA Ready	Active LOW indicates that buffers are available for more data. HIGH means buffer full, master must wait
PKTEND	Packet End	Active LOW to terminate current packet with less than full buffer

6.5 DMA Architecture

6.5.1 High-Bandwidth DMA (HBW DMA)

EZ-USB™ FX2G3 uses a dedicated High-BandWidth DMA engine for Slave FIFO transfers. Key features:

- **Zero-copy transfers:** Data moves directly from LVCMOS socket to USB without CPU copying
- **Multiple buffering:** 3 buffers allow continuous data flow (one filling, one transferring, one available)
- **Large buffers:** 60 KB per buffer maximizes throughput

6.5.2 Buffer Configuration

```
/* File: usb_app.h */
/* Number of RAM buffers used on the data path: 3 */
#define SLFF_RX_MAX_BUFFER_COUNT            (3)

/* Size of each RAM buffer used in the data path: 60 KB */
#define SLFF_RX_MAX_BUFFER_SIZE             (61440)
```

6.5.3 DMA Channel Creation Code Walkthrough

```
/* File: usb_app.c, Function: Cy_USB_AppSetupEndpDmaParamsHs() */

/* Step 1: Extract endpoint info from descriptor */
Cy_USBD_GetEndpNumMaxPktDir(pEndpDscr, &endpNumber, &maxPktSize, &dir);

/* Step 2: Configure DMA channel for this endpoint */
if (endpNumber == BULK_IN_EP1_INDEX) {

/* Buffer configuration */
dmaConfig.size  = SLFF_RX_MAX_BUFFER_SIZE;   /* 60KB per buffer */
dmaConfig.count = SLFF_RX_MAX_BUFFER_COUNT;  /* 3 buffers */

/* Channel type: IP-to-IP means LVCMOS → USB, no CPU copy involved */
dmaConfig.chType = CY_HBDMA_TYPE_IP_TO_IP;

/* Producer socket: Where data comes FROM (LVCMOS interface) */
dmaConfig.prodSckCount = 1;
dmaConfig.prodSck[0] = CY_HBDMA_LVDS_SOCKET_00;  /* Socket 0 for Thread 0 */
```

```
 /* Consumer socket: Where data goes TO (USB endpoint) */
dmaConfig.consSckCount = 1;
dmaConfig.consSck[0] = (cy_hbdma_socket_id_t)(CY_HBDMA_USBHS_IN_EP_00 + endpNumber);

/* Callback when buffer is ready */
dmaConfig.cb = Cy_Slff_AppHbDmaRxCallback;

/* Create the channel */
mgrStat = Cy_HBDma_Channel_Create(pUsbApp->pUsbdCtxt->pHBDmaMgr,
                        &(pUsbApp->endpInDma[endpNumber].hbDmaChannel),
                        &dmaConfig);
}
```

6.6 Application Workflow

6.6.1 Application Startup Sequence

6.6.1.1 System Initialization (main.c)

- Initialize clocks, GPIOs, debug UART
- Initialize FreeRTOS kernel
- Create application task

6.6.1.2 USB Stack Initialization (Cy_USB_AppInit)

- Initialize USBD layer
- Register USB descriptors
- Register event callbacks (RESET, SET_CONFIG, etc.)
- Create message queue for events

6.6.1.3 FPGA Configuration (Cy_Slff_AppTaskHandler)

- Configure SMIF for FPGA bitfile loading
- Load FPGA bitfile from external flash
- Wait for FPGA CDONE# signal
- Configure FPGA registers via I2C

6.6.1.4 LVCMOS Interface Initialization (Cy_Slff_LvdsInit)

- Configure GPIF state machine
- Set up LVCMOS PHY (16-bit or 8-bit mode)
- Register GPIF event callbacks
- Enable LVCMOS interrupts

6.6.1.5 USB Connection Enable

- Check VBus presence
- Enable USB D+/D- pull-ups
- Device visible to host

6.6.1.6 USB Enumeration (Host-driven)

- Host requests descriptors
- Host assigns address
- Host selects configuration
- SET_CONFIG callback creates and enables DMA channels

6.6.1.7 Data Streaming Ready

- Host application can start bulk transfers

6.6.2 SET_CONFIGURATION Handler

When the host sends SET_CONFIGURATION, the following sequence occurs:

```
/* File: usb_app.c, Function: Cy_USB_AppSetCfgCallback() */

/* Step 1: Enable endpoints based on configuration */
Cy_USBD_EnableEndpoint(pUsbdCtxt, BULK_IN_ENDPOINT_1, CY_USB_ENDP_DIR_IN);

/* Step 2: Create DMA channels for each endpoint */
Cy_USB_AppSetupEndpDmaParamsHs(pAppCtxt, pEndpDscr);

/* Step 3: Mark channels as created */
pAppCtxt->hbChannelCreated = true;
```

6.6.3 Data Transfer Flow

```
/* File: usb_app.c, Data transfer sequence */

/* Step 1. Host initiates transfer by sending BULK_IN token */
/*    → USB controller waits for data in endpoint buffer */

/* Step 2. FPGA starts writing data */
/*    → Data flows: LVCMOS → Socket → HBW SRAM buffer */

/* Step 3. Buffer fills up → DMA callback triggered */
void Cy_Slff_AppHbDmaRxCallback(cy_stc_hbdma_channel_t *handle,
                      cy_en_hbdma_cb_type_t type,
                      cy_stc_hbdma_buff_status_t *pbufStat,
```

```
                    void *userCtx)
{
  /* Get buffer info */
  status = Cy_HBDma_Channel_GetBuffer(handle, &buffStat);

  /* Commit buffer to USB endpoint */
  status = Cy_HBDma_Channel_CommitBuffer(handle, &buffStat);

  /* Data now available for USB controller to send */
}

/* Step 4. USB controller sends data to host */
/*   → Transfer complete */
```

7 Debugging the code examples

This section describes how to debug using the USBFS CDC port of KIT_FX2G3_104LGA DVK. By default, the code examples enable debug logs on the USB-FS CDC port (J7) of KIT_FX2G3_104LGA DVK. To read from a UART Tx pin through SCB instead, use the code example's Makefile to set the value of the `USBFS_LOGS_ENABLE` macro to `0`.

Note: Do the following to enable UART logging through SCB for the `CYUSB2315-BF104AXI`:

a) Ensure the `USBFS_LOGS_ENABLE` macro is set to `0` in the Makefile

b) In the *main.c* source file, modify the SCB configuration by changing `LOGGING_SCB` from `(SCB4)` to `(SCB0)`, `LOGGING_SCB_IDX` from `(4)` to `(0)` and the value of `dbgCfg.dbgIntfce` from `CY_DEBUG_INTFCE_UART_SCB4` to `CY_DEBUG_INTFCE_UART_SCB0`

c) Launch the Device Configurator tool to disable `SCB4`, and enable `SCB0` for UART. Set 921600 baud, 9 Oversample, and use the `16 bit Divider 0 clk` clock

The verbosity of code example's debug logs can be customized. The `DEBUG_LEVEL` macro in *main.c* can be set to the following values for debugging:

Table 15 Debug levels

#	Macro value	Purpose
1	1 u	Enable error messages
2	2u	Enable warning and error messages
3	3u	Enable info, warning, and error messages
4	4u	Enable all messages

8 Troubleshooting

EZ-USB™ FX device enumeration	
Issue	EZ-USB™ FX2G3 device does not enumerate
Description	The WinUSB device is enumerated in the Device Manager, but not listed in the Control Center device tree list in the left pane
Reason	This error is observed if the `DeviceInterfaceGUID {01234567-2A4F-49EE-8DD3-FADEA377234A}` entry is missing in the Windows registry
Solution	Verify that the **DeviceInterfaceGUID** key has the value {01234567-2A4F-49EE-8DD3-FADEA377234A} at the following registry path: *Computer\HKEY_LOCAL_MACHINE\SYSTEM\CurrenstControlSet\Enum\USB\VID_04B4&PID_XXXX<serial_string>\Device Parameters* To find the **serial_string** value: 1. Open **Device Manager** 2. Right-click the USB device and select **Properties** 3. Go to the **Details** tab 4. Choose **Device Instance Path** from the **Property** drop-down The value displayed includes the vendor ID, product ID, and serial string For example, in `USB\VID_04B4&PID_XXXX\5&33C730EA&0&4`, the serial string is `5&33C730EA&0&4`

Revision history

Document revision	Date	Description of changes
**	2024-09-26	Initial release
*A	2024-10-09	Minor updates
*B	2024-10-23	Added information on using the ModusToolbox™ IDE
*C	2025-06-19	• Added new code examples • Added troubleshooting section • Updated
*D	2025-09-01	Added information for using the code examples with specific products
*E	2025-09-04	Added two new code examples: HID CFU and Protocol Analyzer
*F	2025-11-07	Removed “restricted” to release to web
*G	2026-03-04	Added new chapter 6 with Slave FIFO IN code example details

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Email:

erratum@infineon.com

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